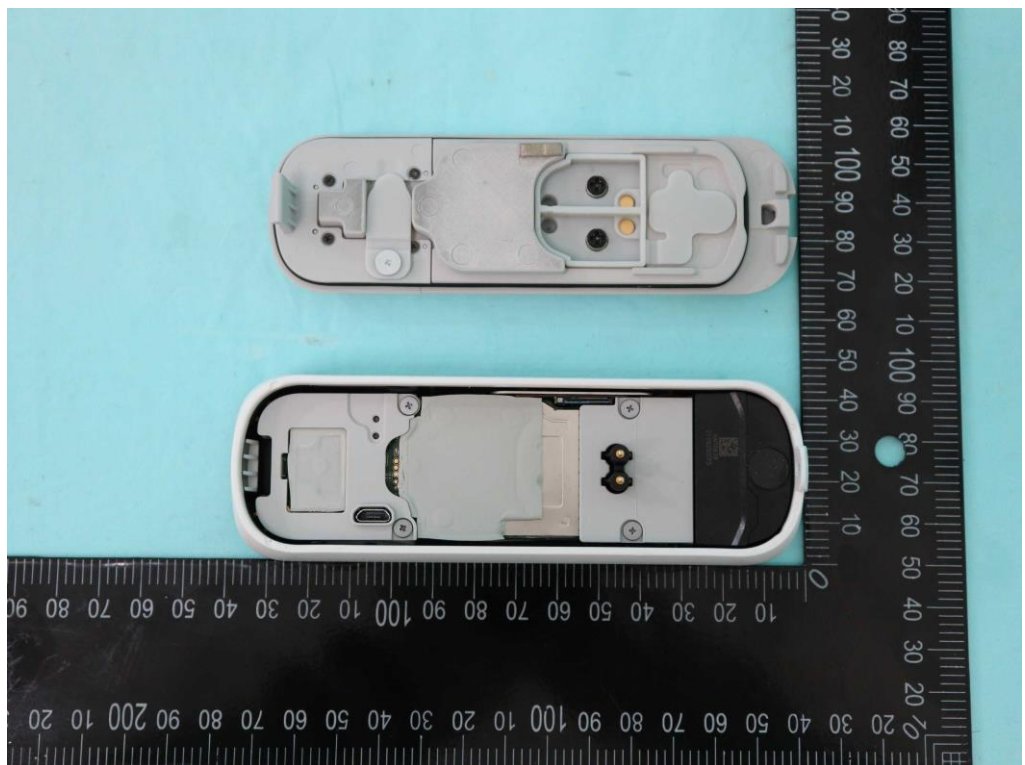
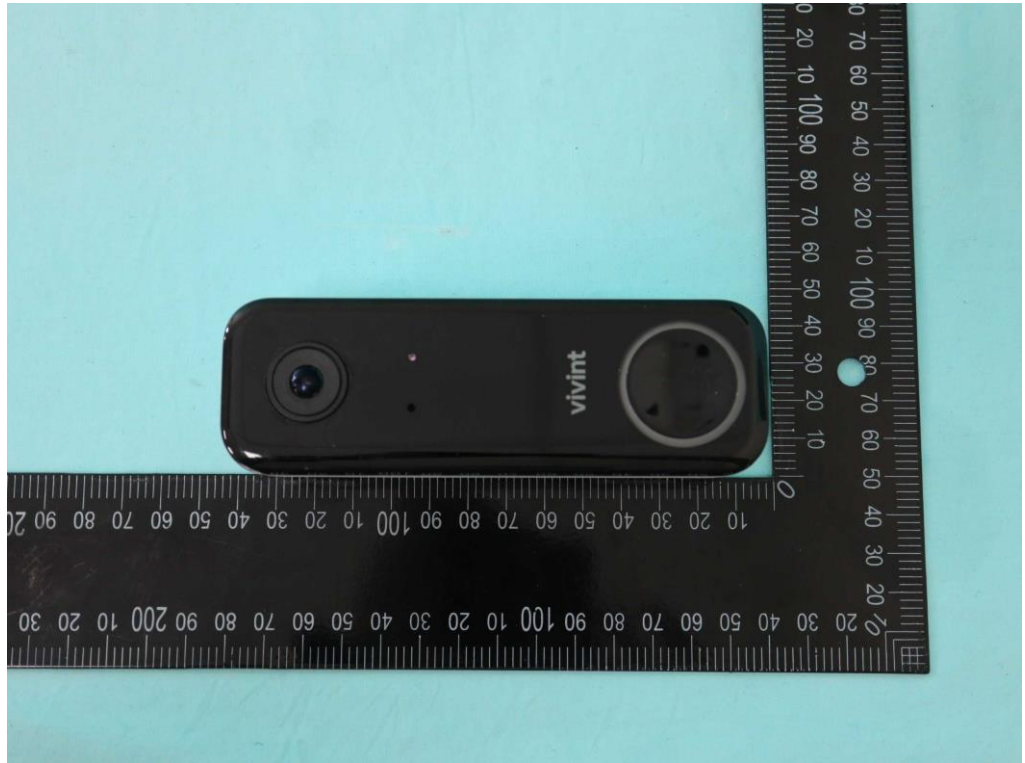
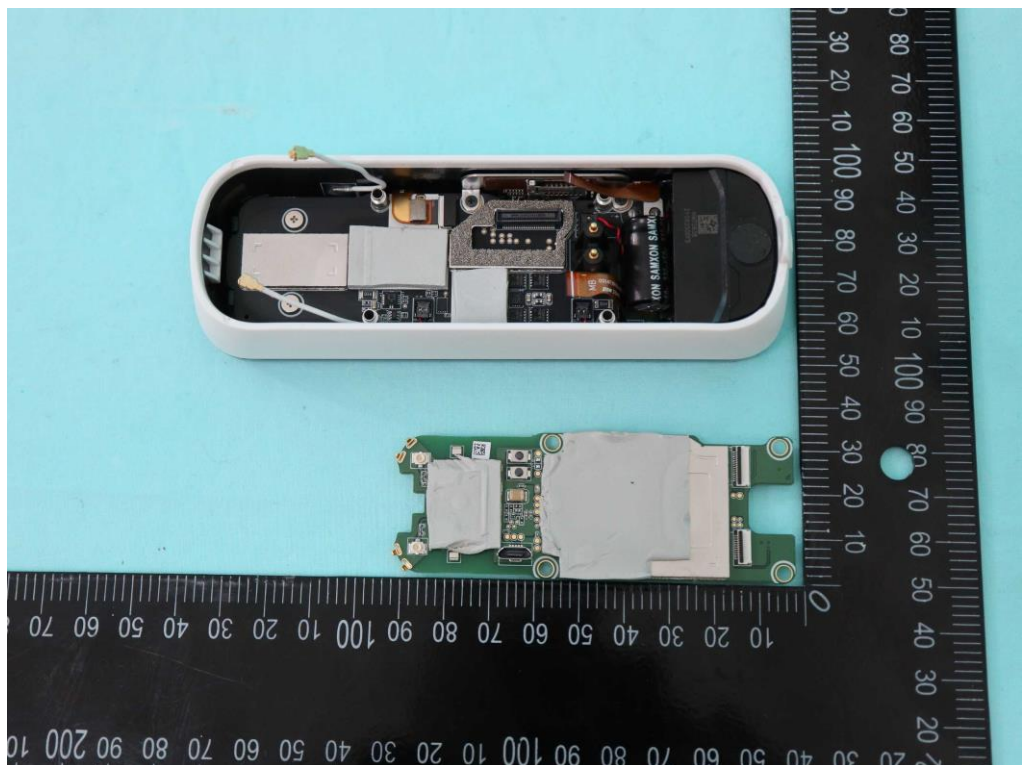
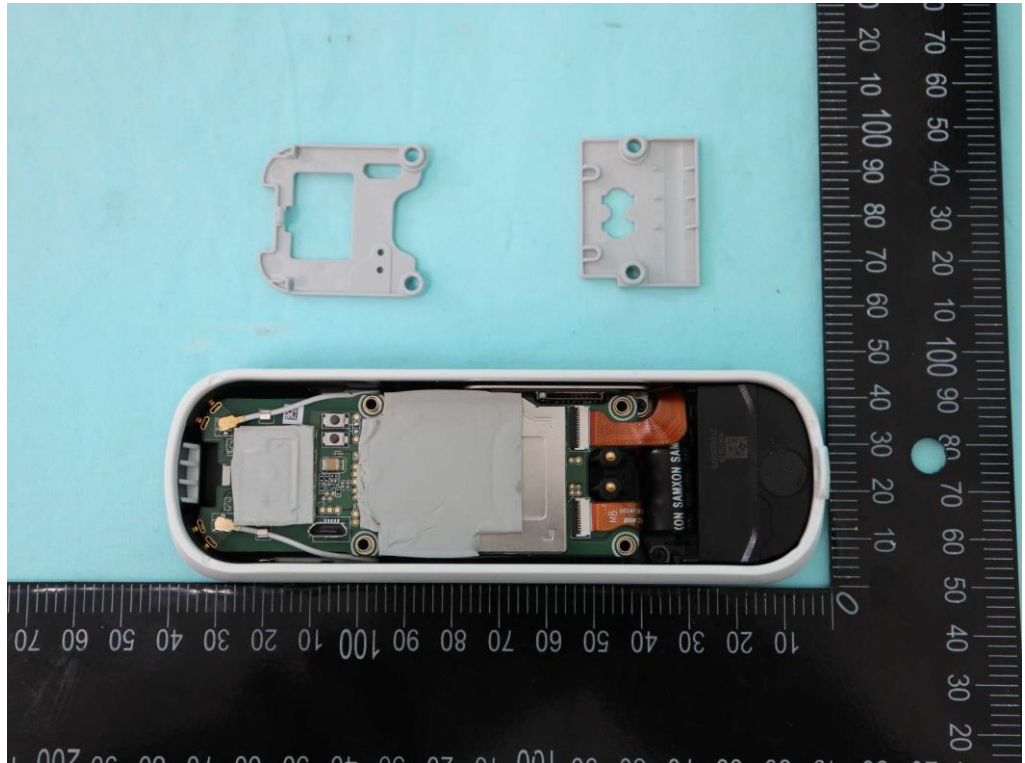
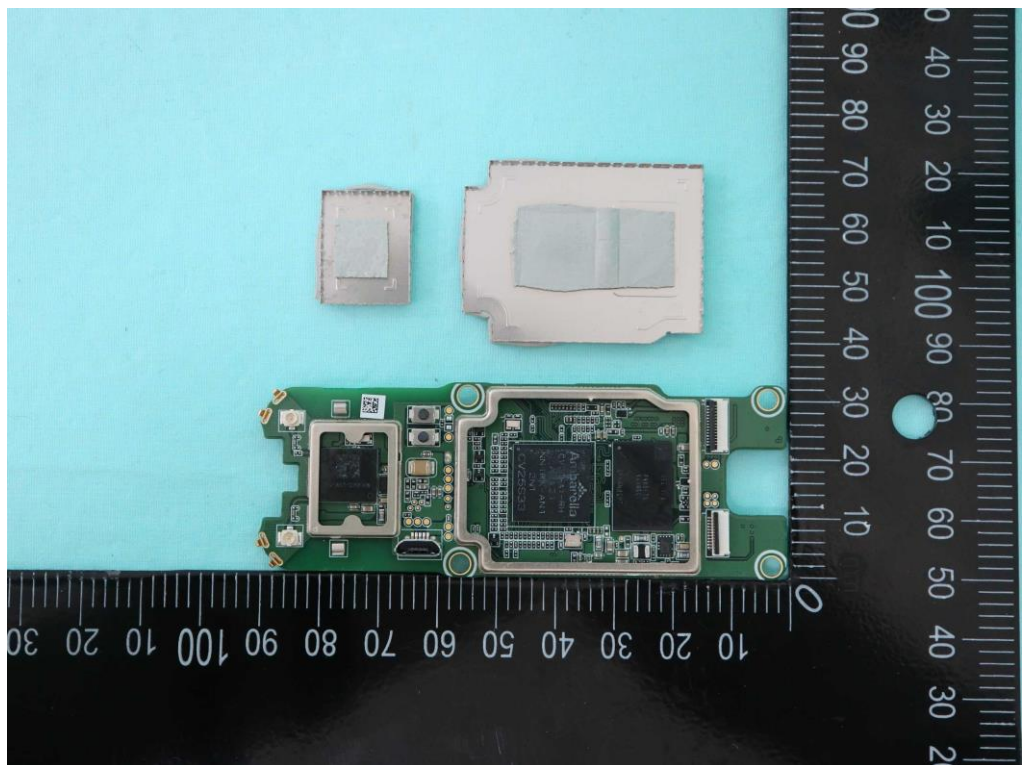
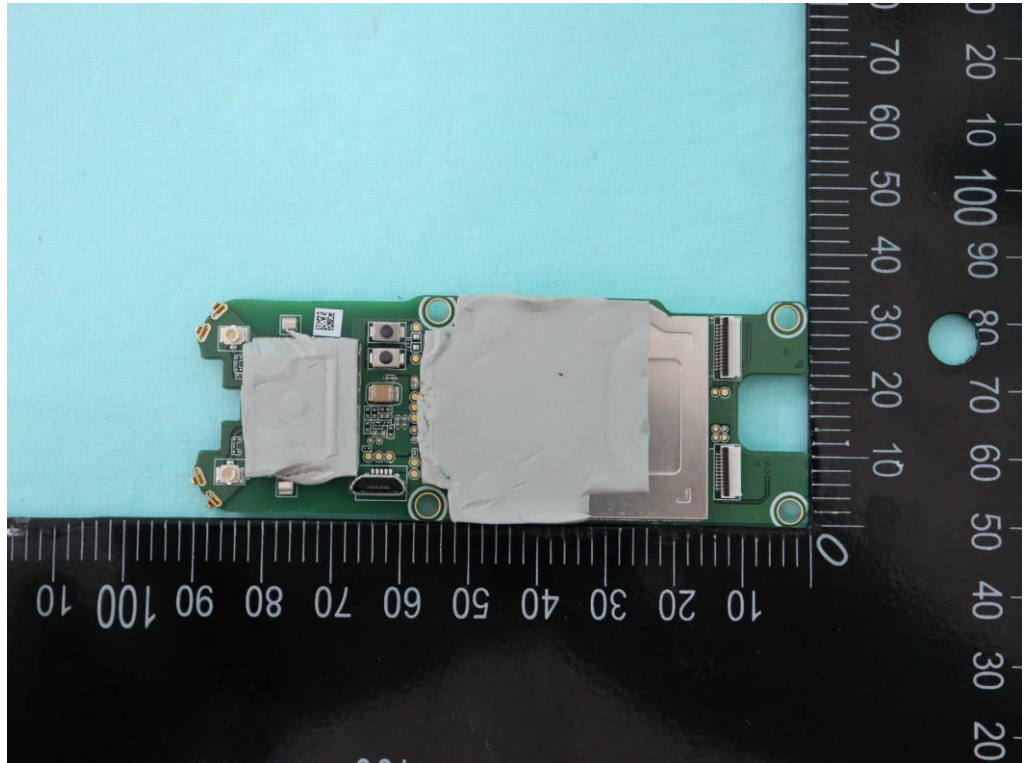
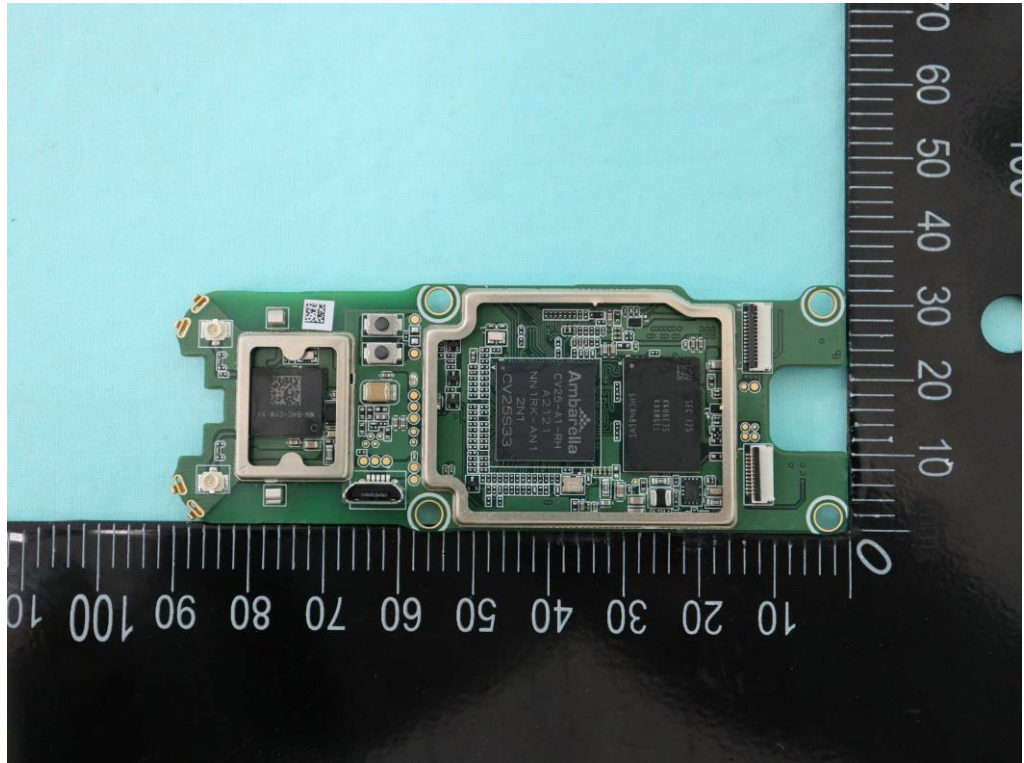


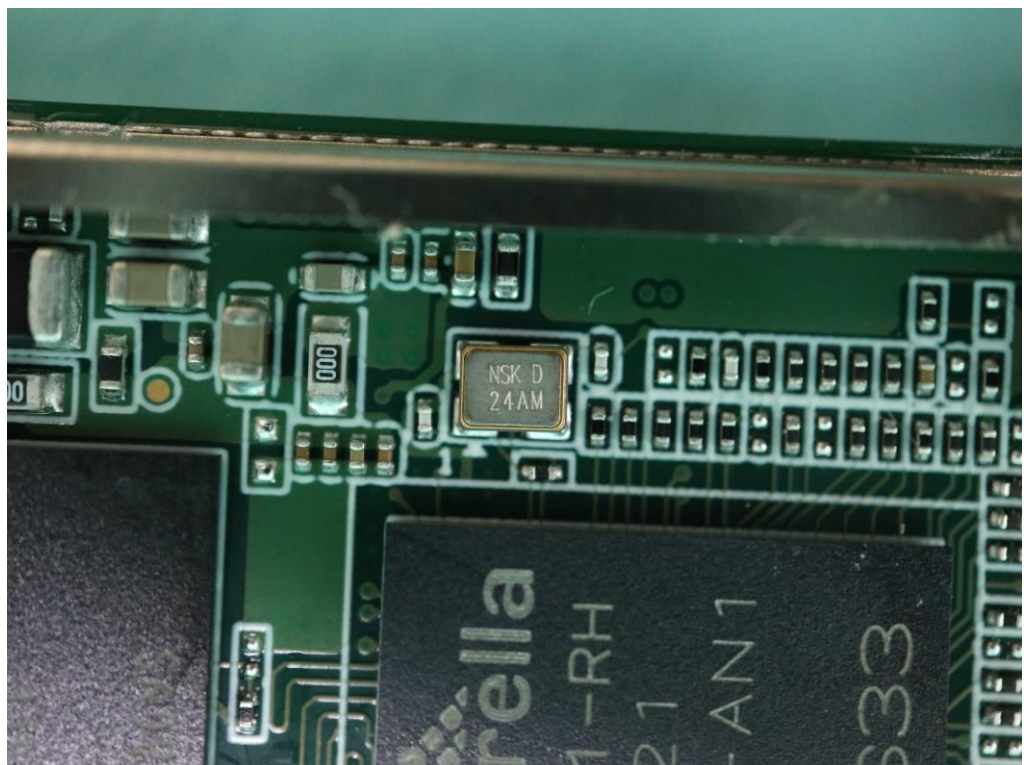




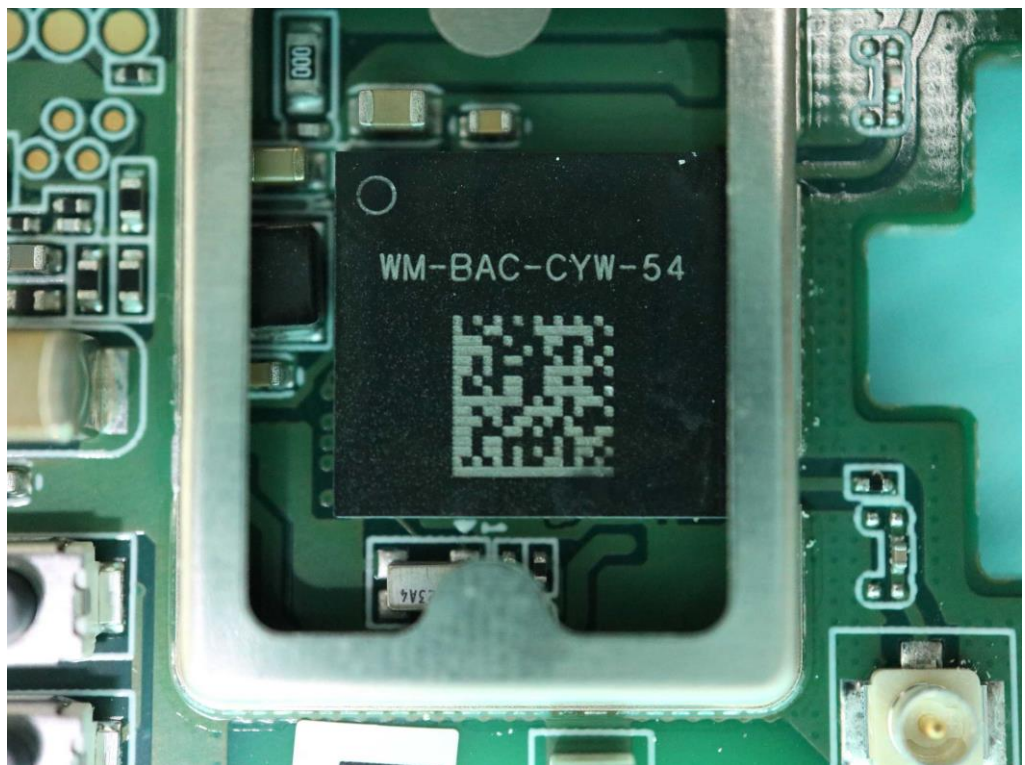
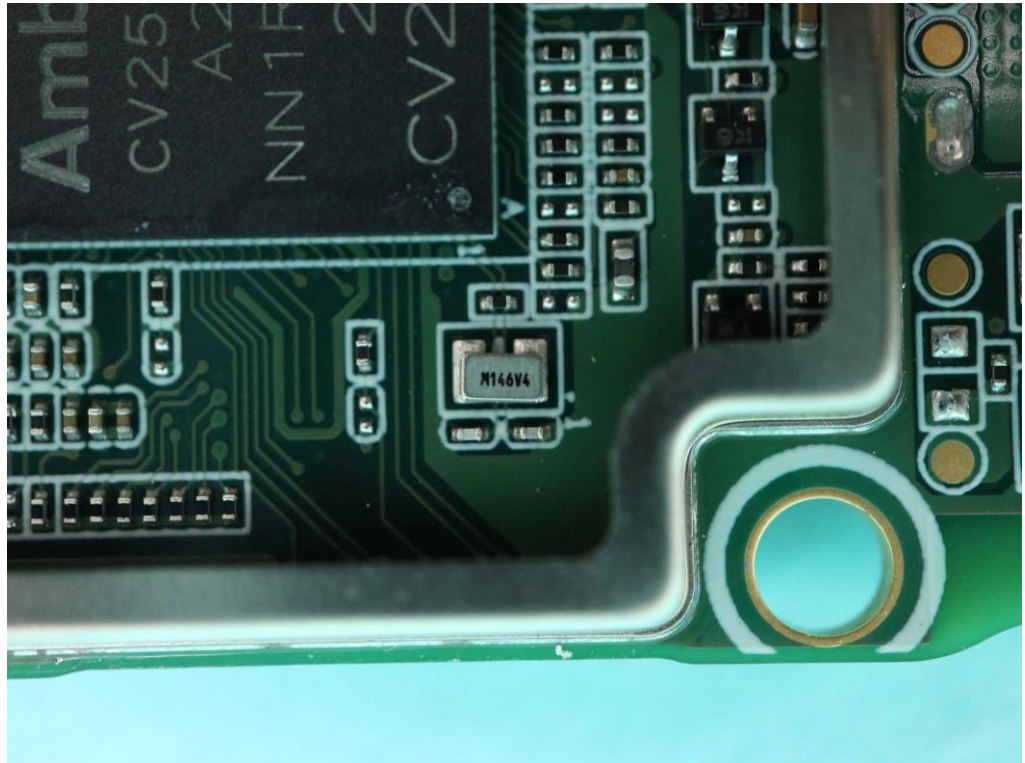


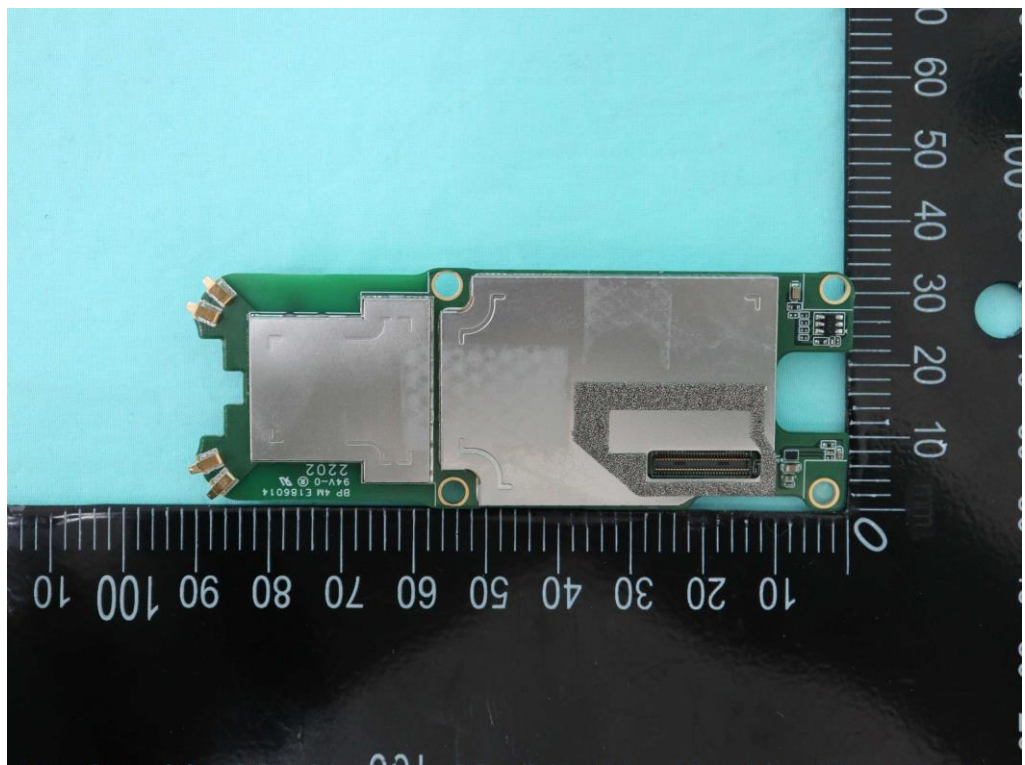
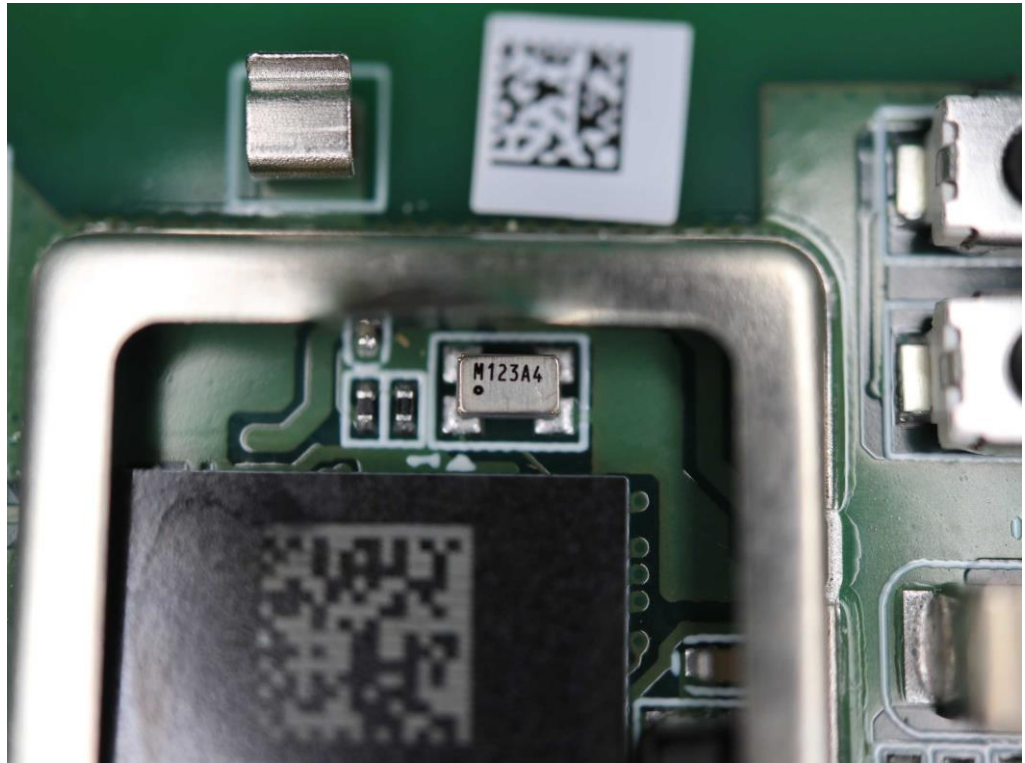




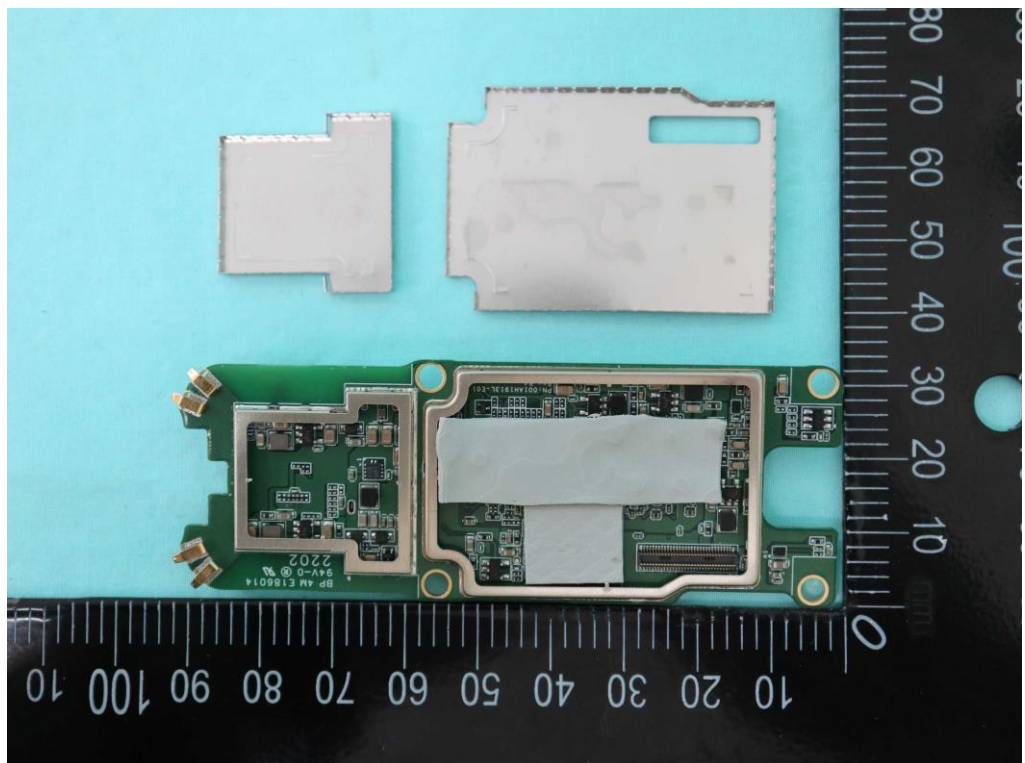
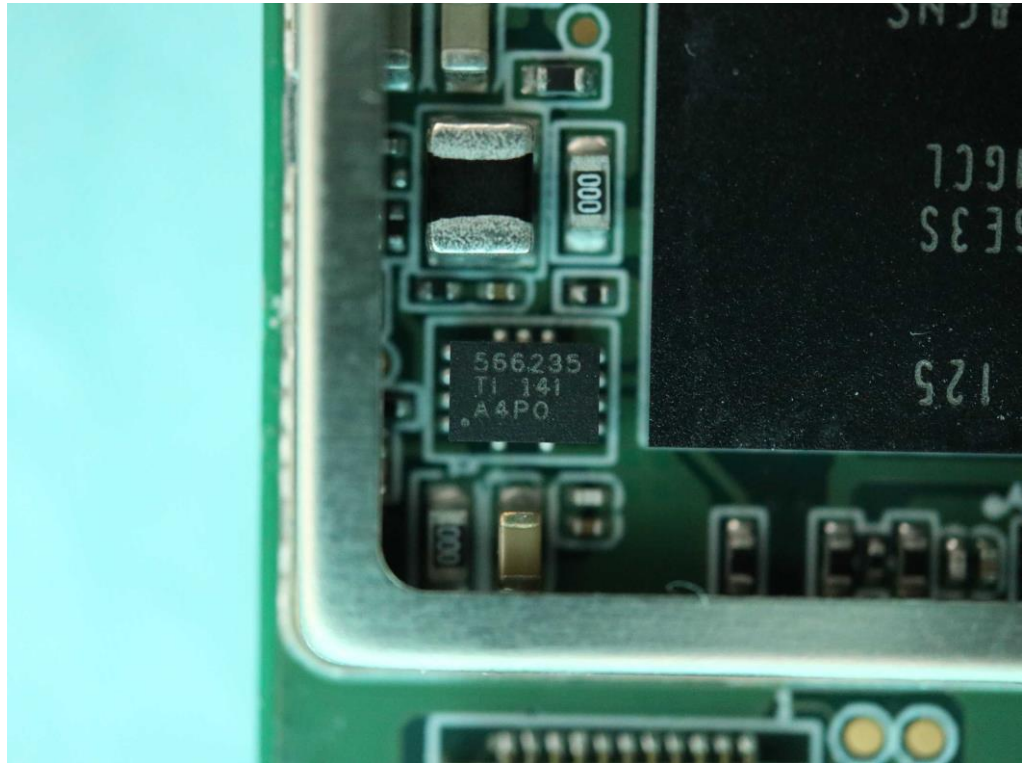




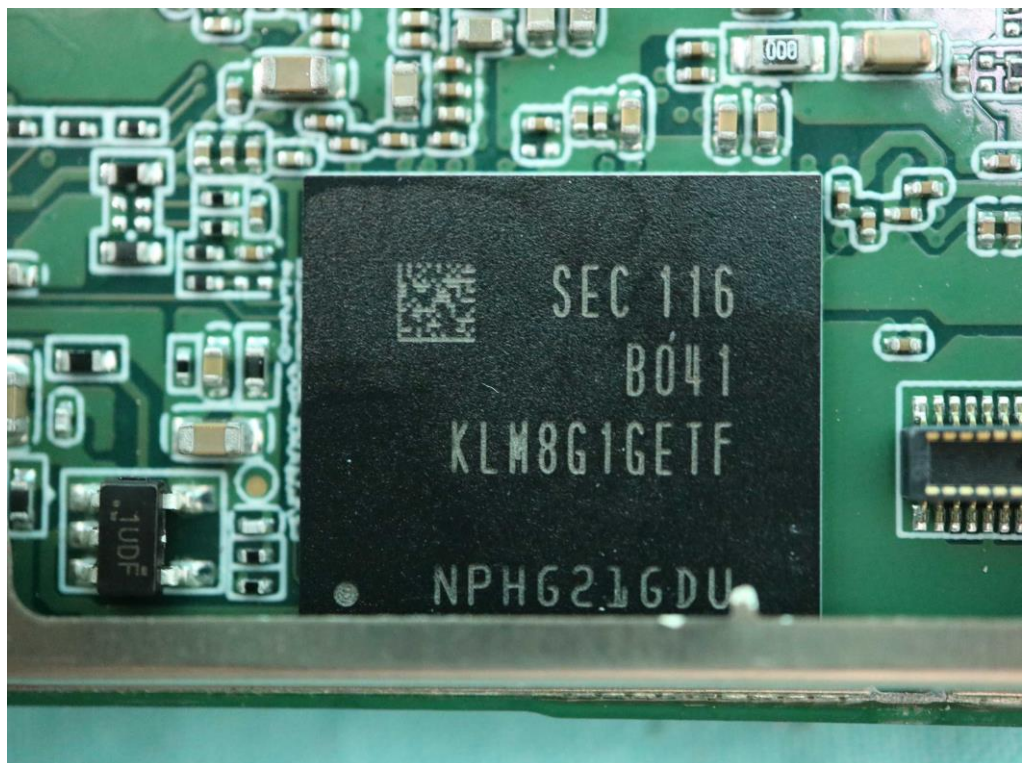
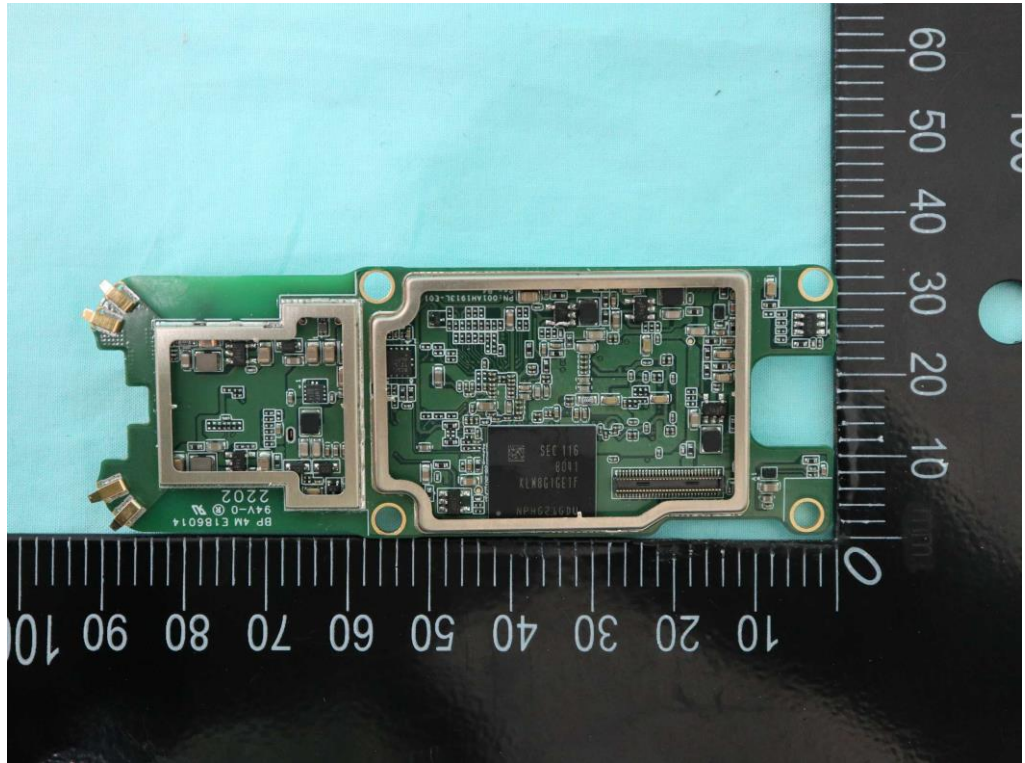


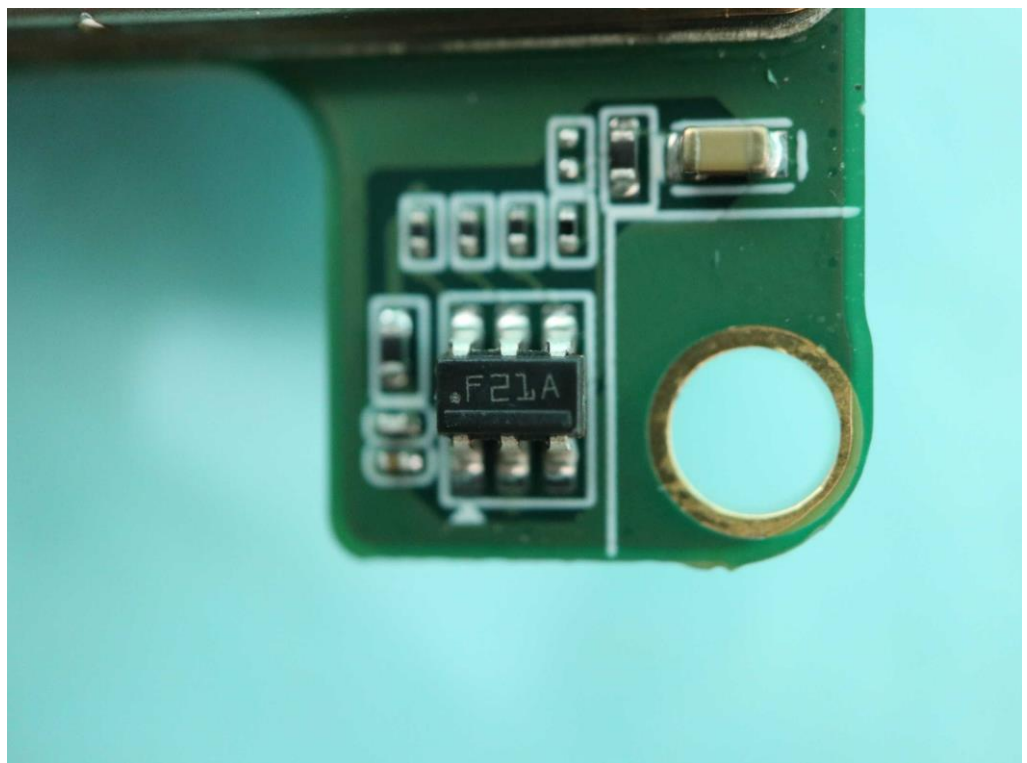
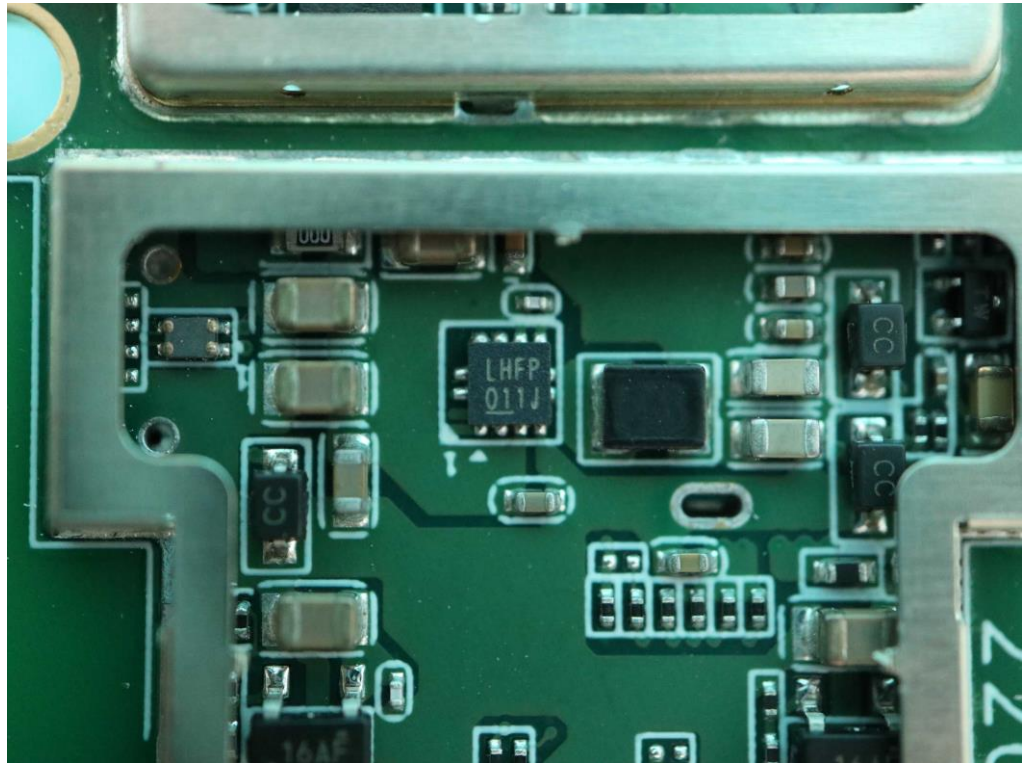




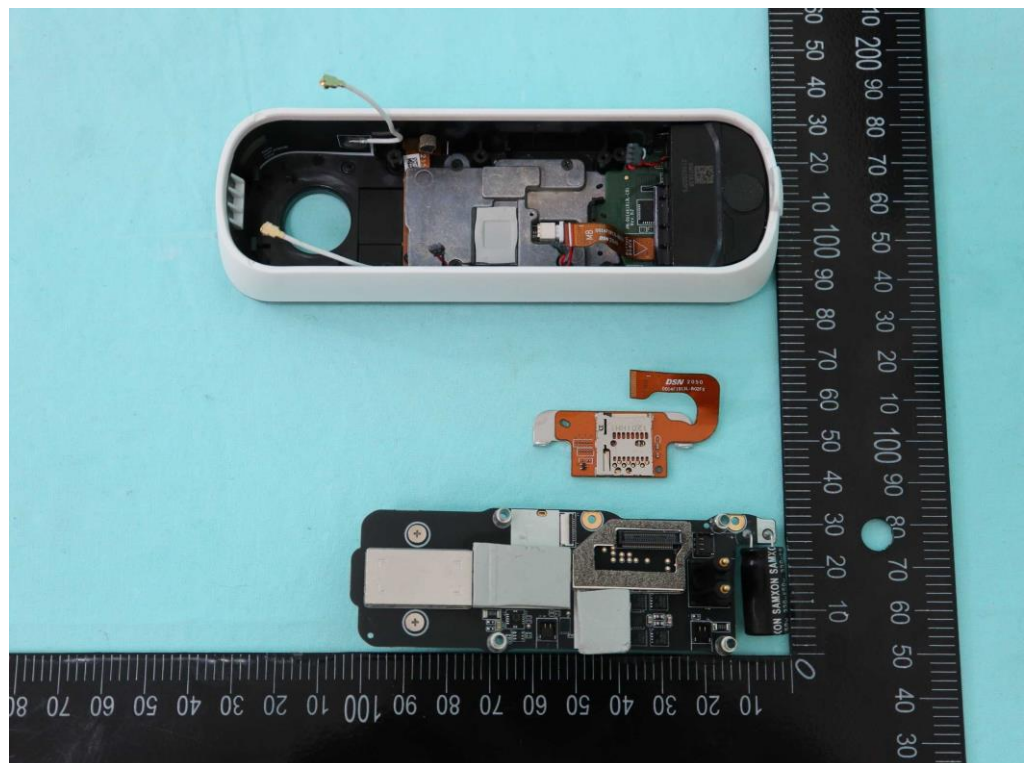
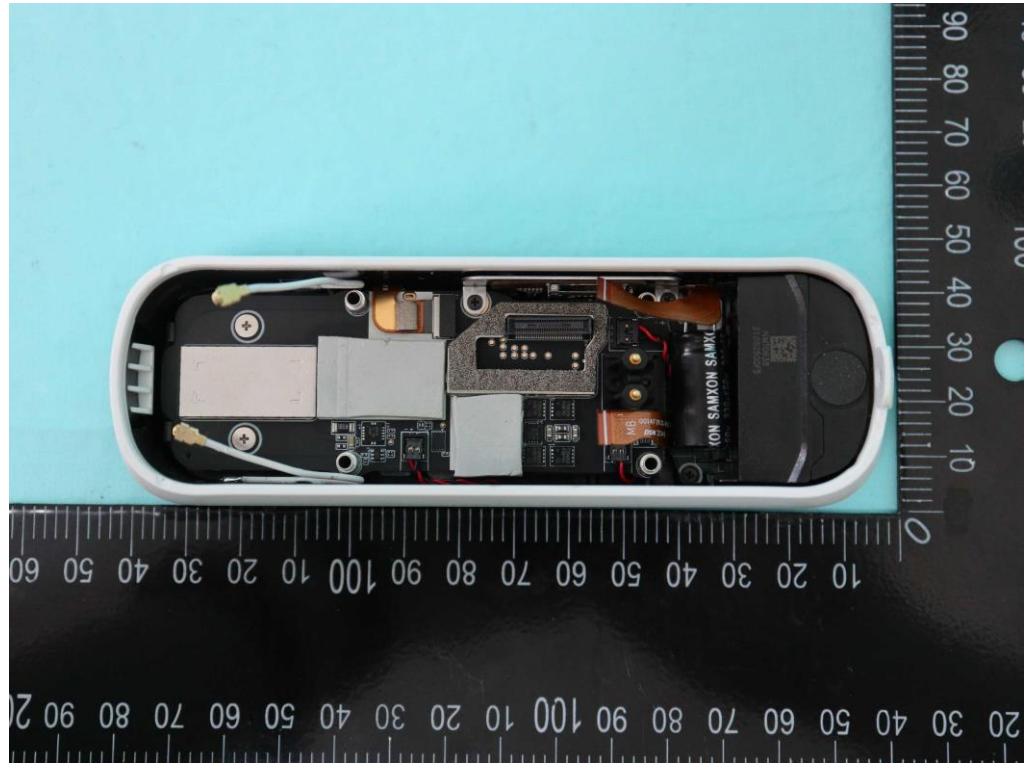


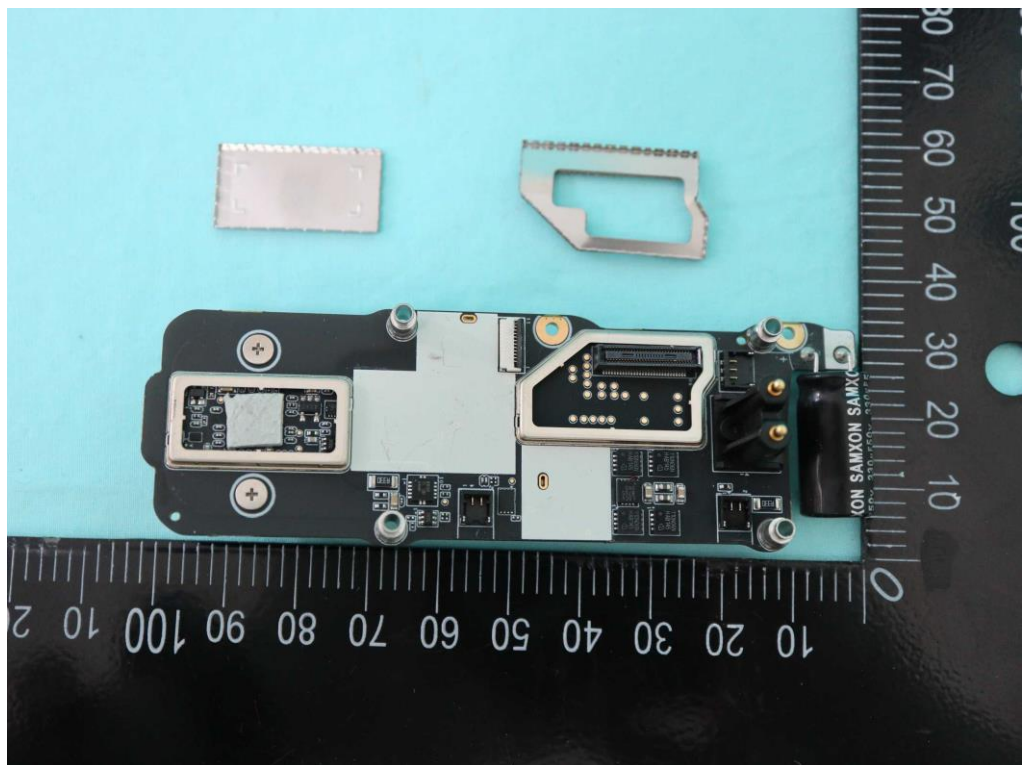
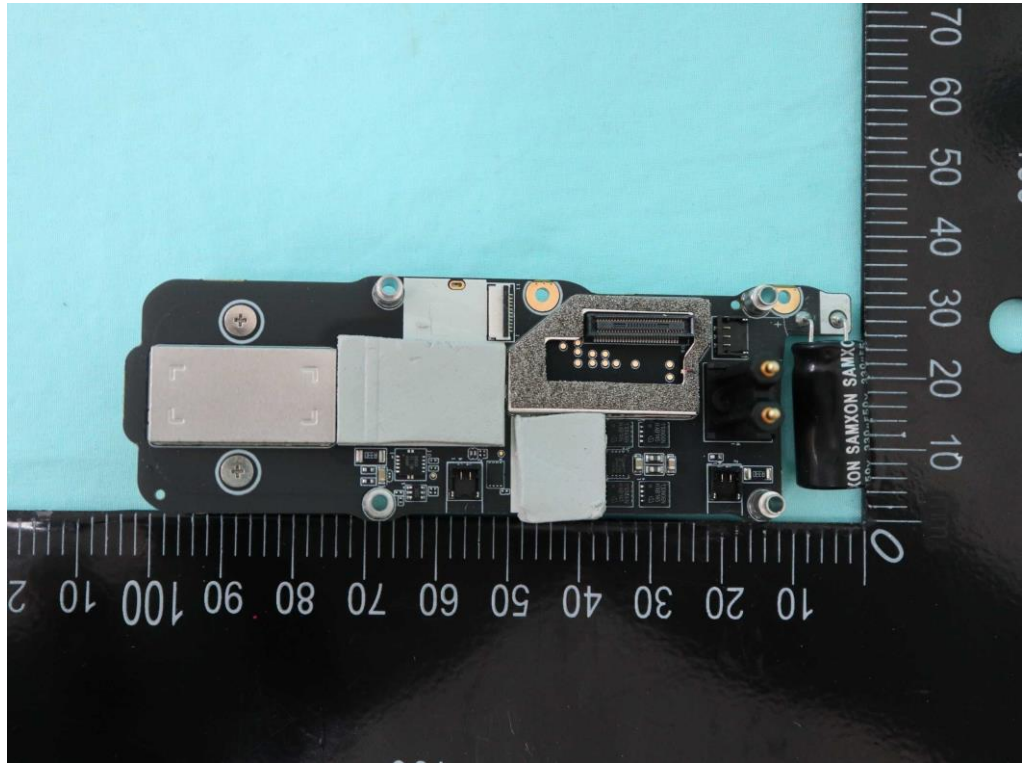




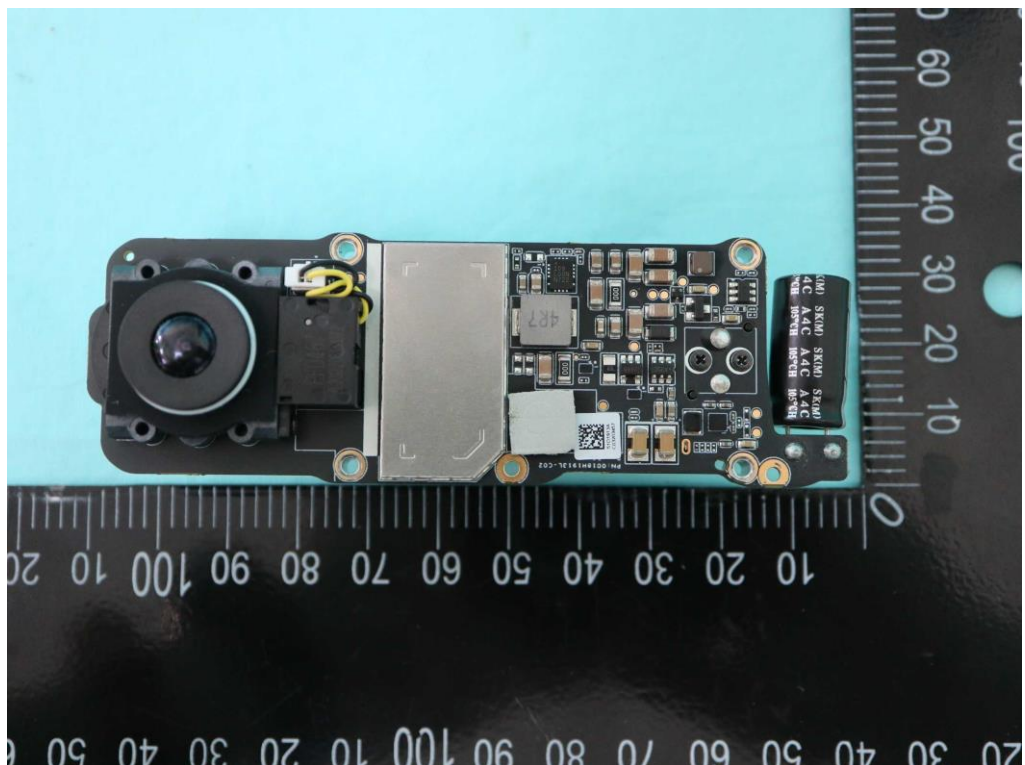
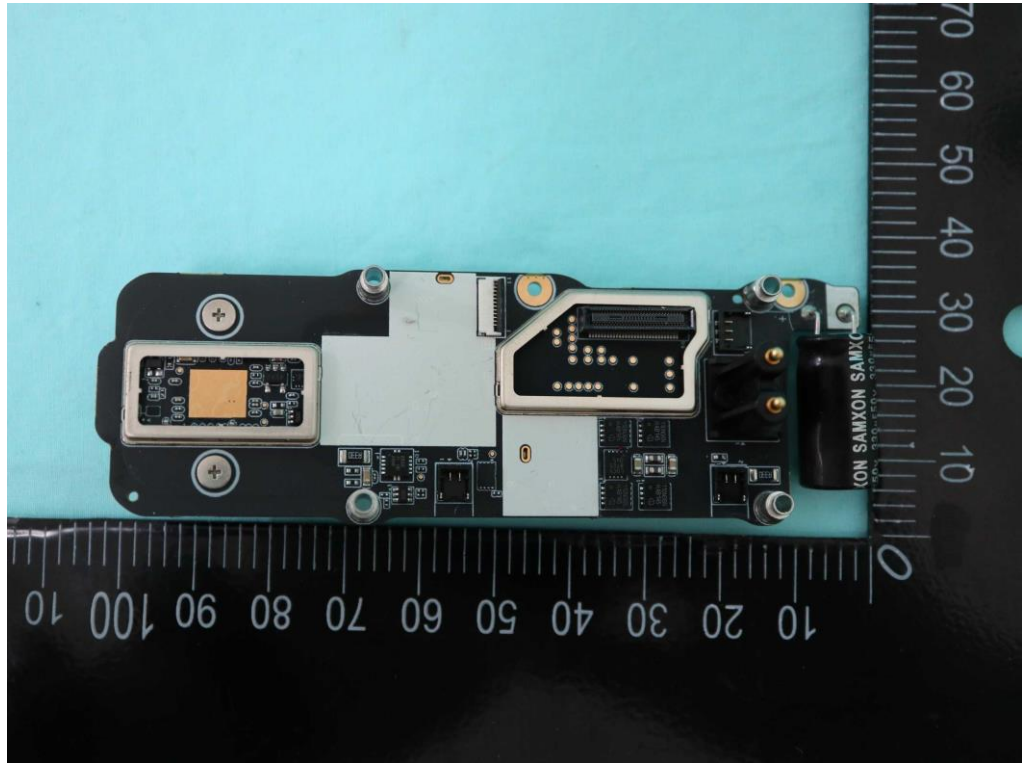


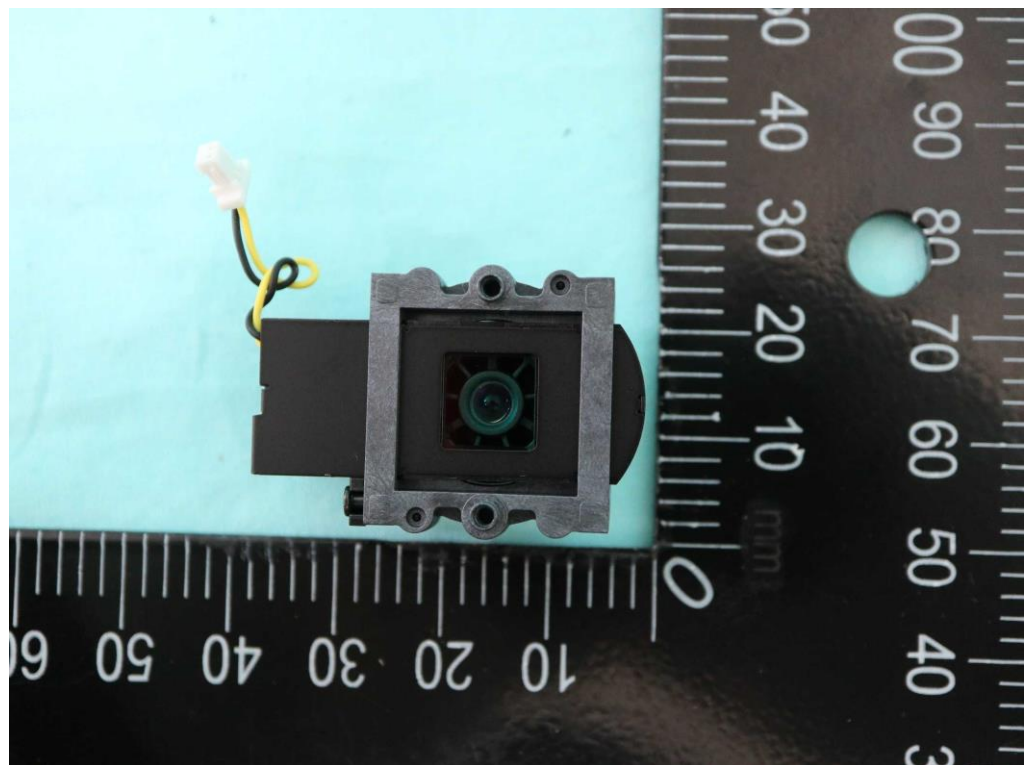
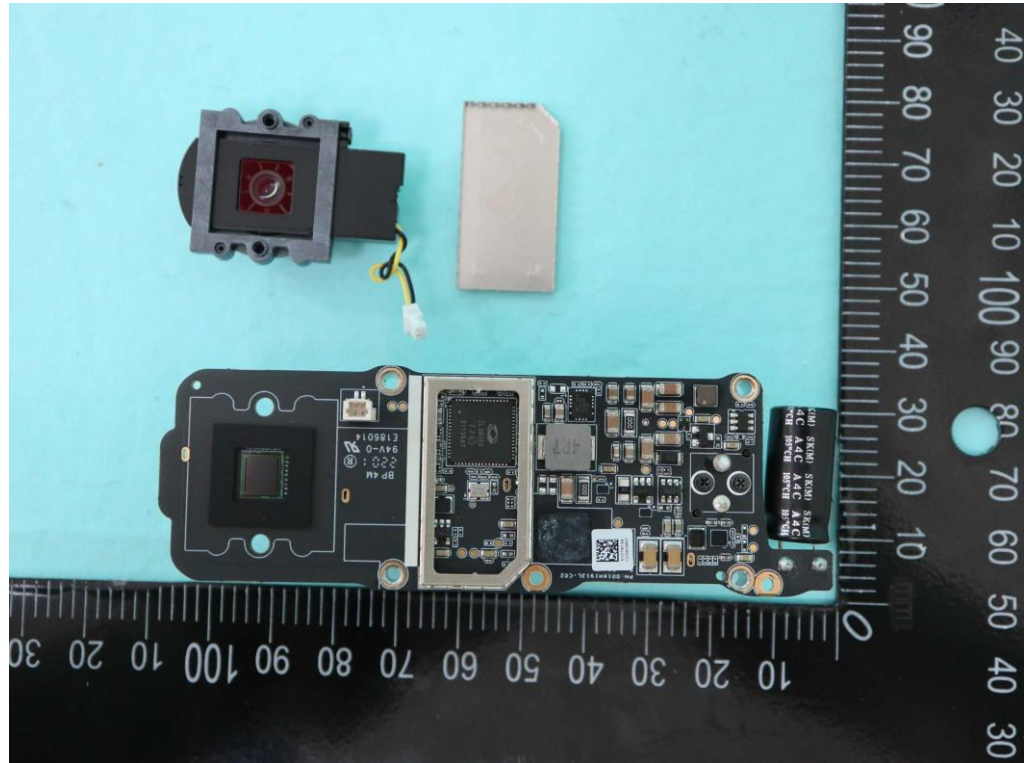




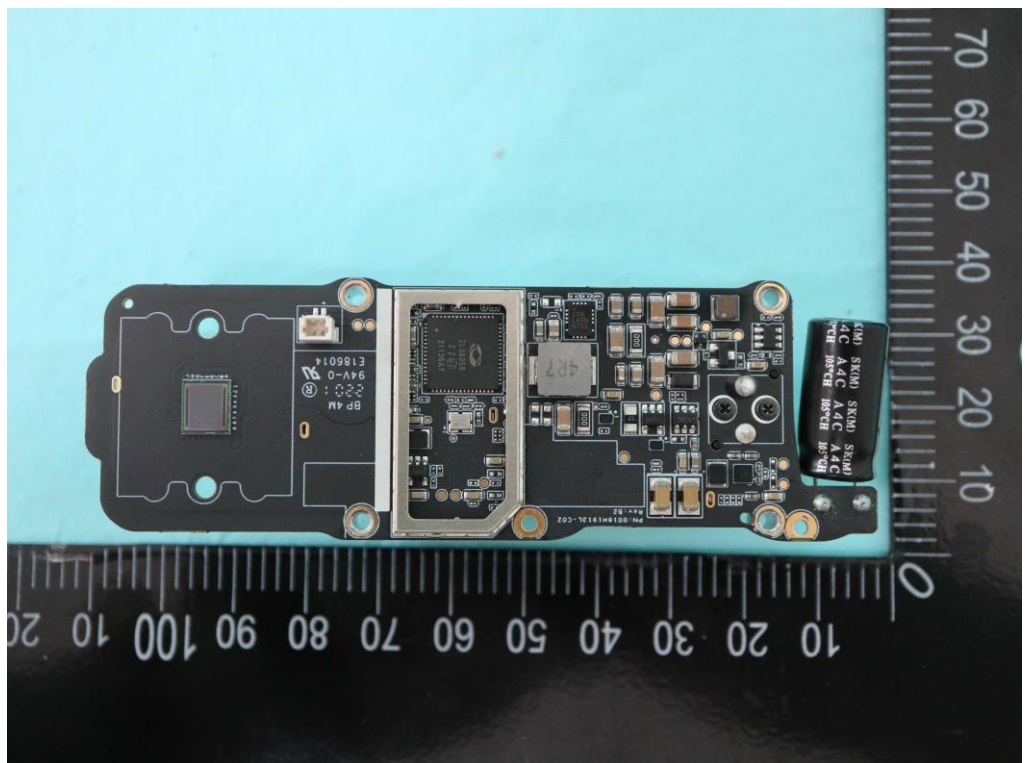
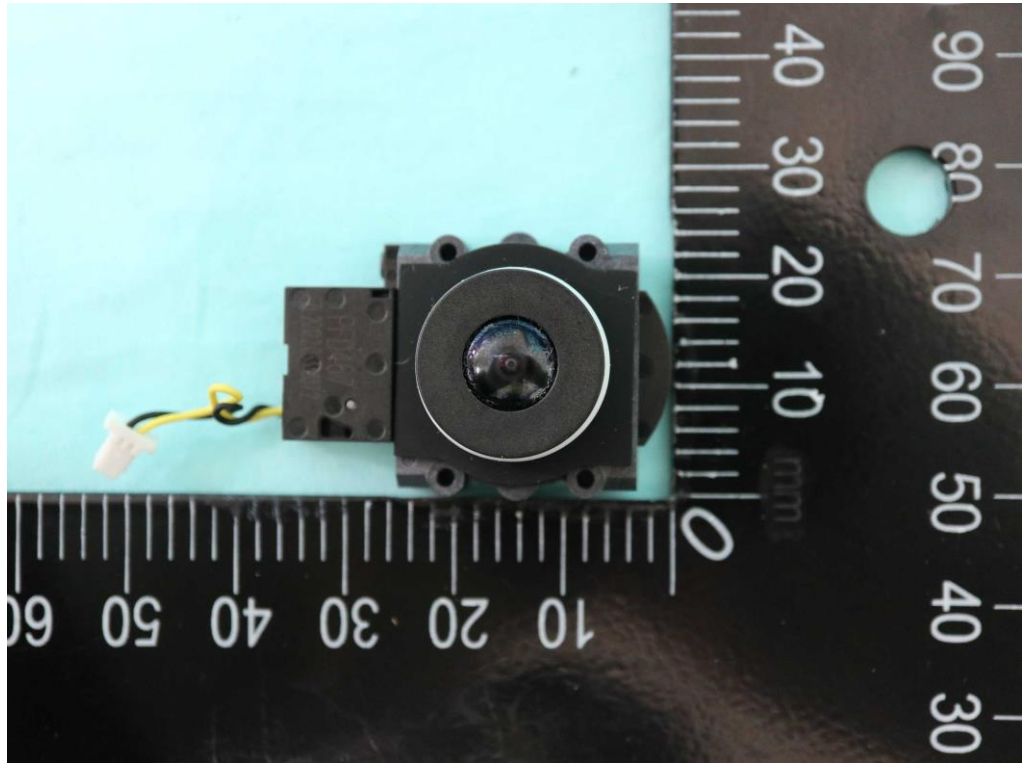






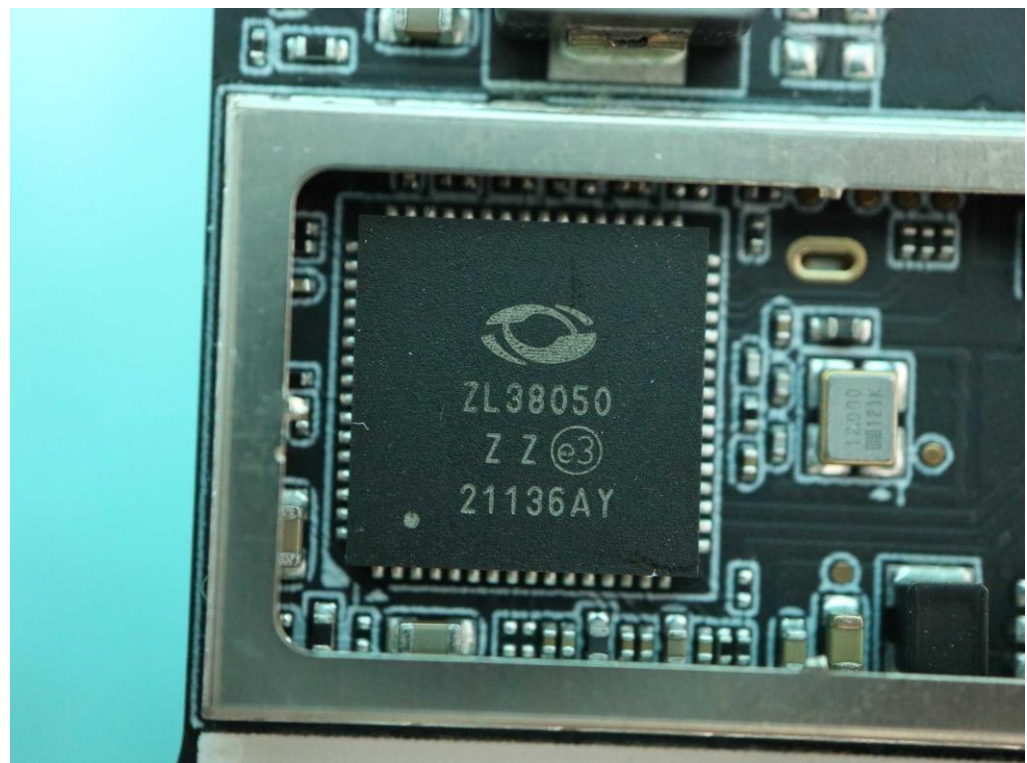




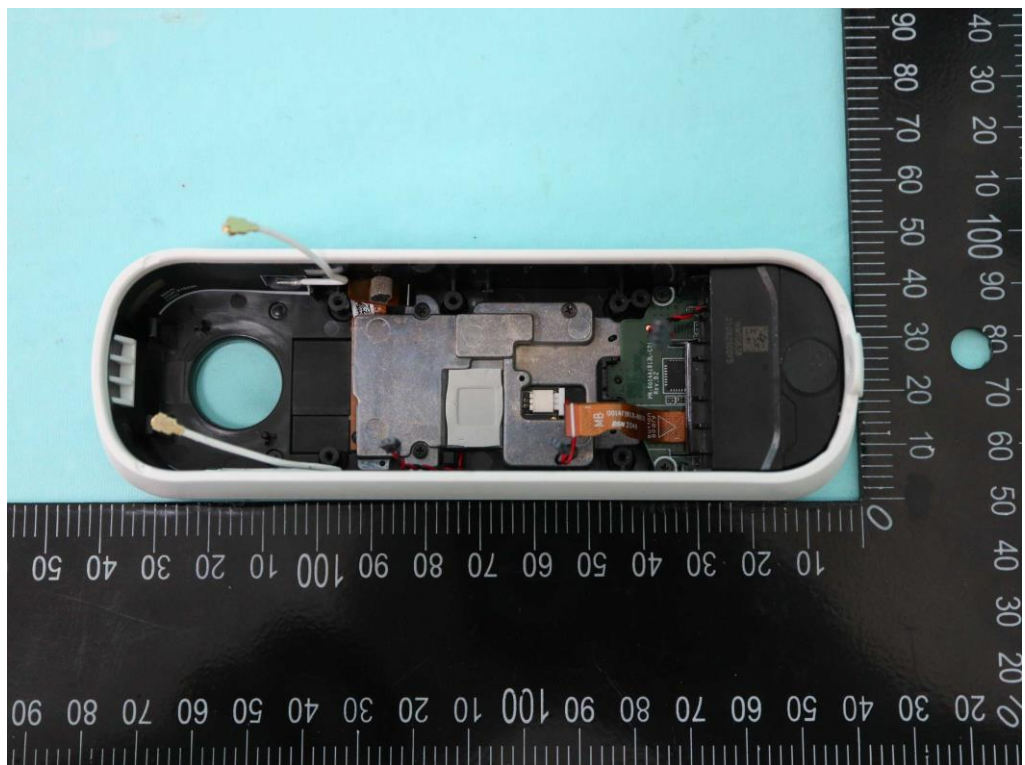
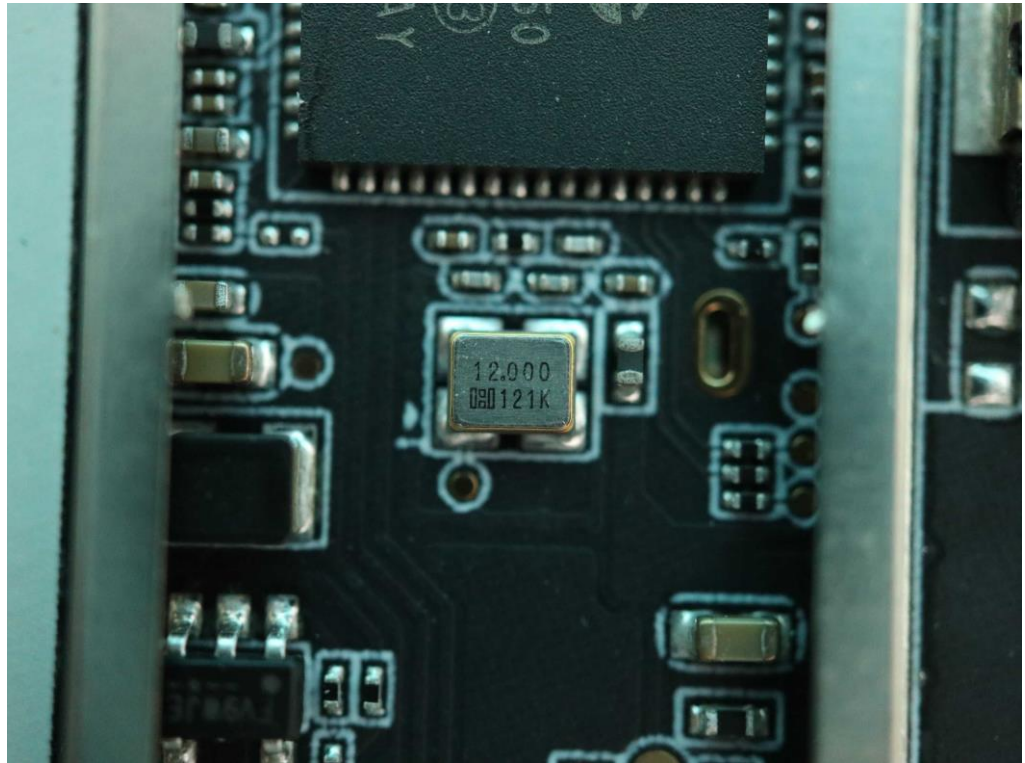


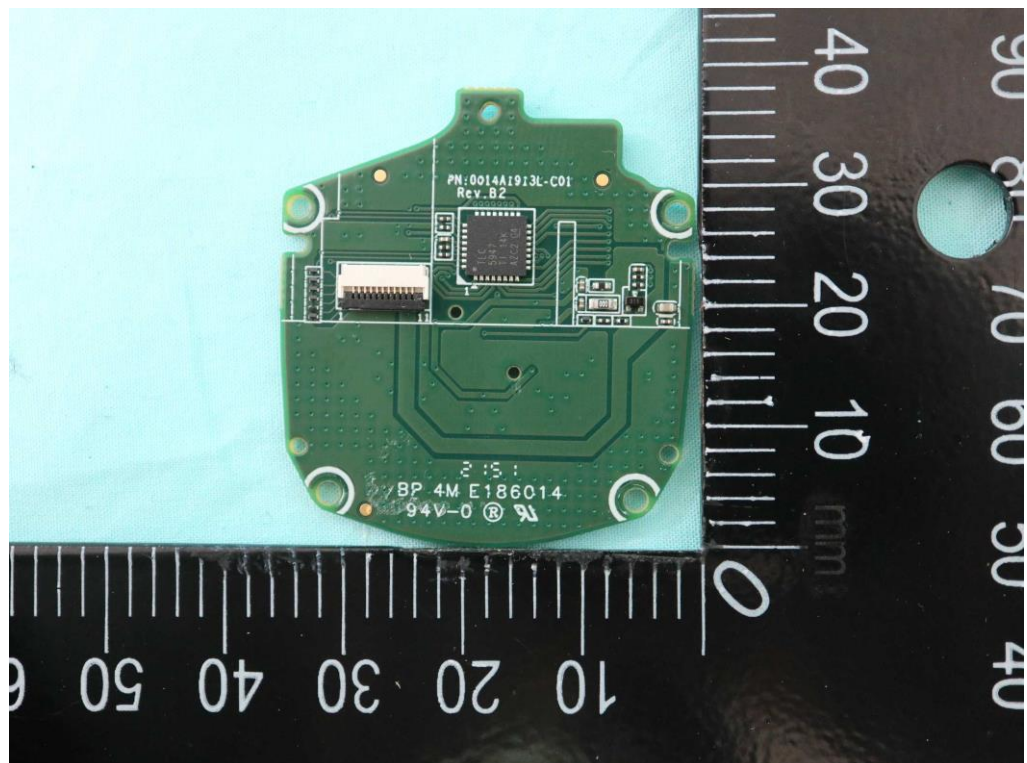
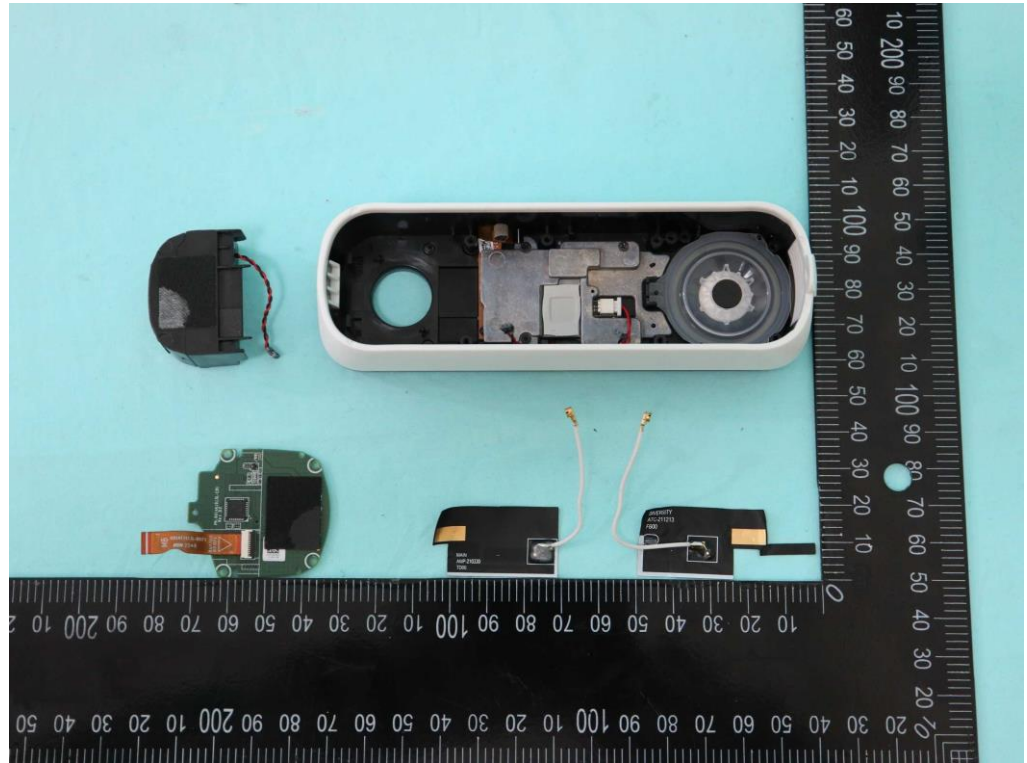


A photograph of a disassembled smartphone, showing the internal components laid out on a light blue surface. A ruler is placed horizontally at the bottom of the frame for scale. The components include: a black battery pack with white text (KMD SKMM SKMM SKMM, C A4C A4C A4C A4C, VCL 1050mAh 1050mAh 1050mAh 1050mAh); a logic board with various chips and components, including a large square chip labeled '4R7'; a camera module with a lens and sensor; and a small black component labeled 'BP 4U'. The phone's frame is visible, showing the mounting points for these components. The ruler shows measurements in centimeters, ranging from 0 to 70.

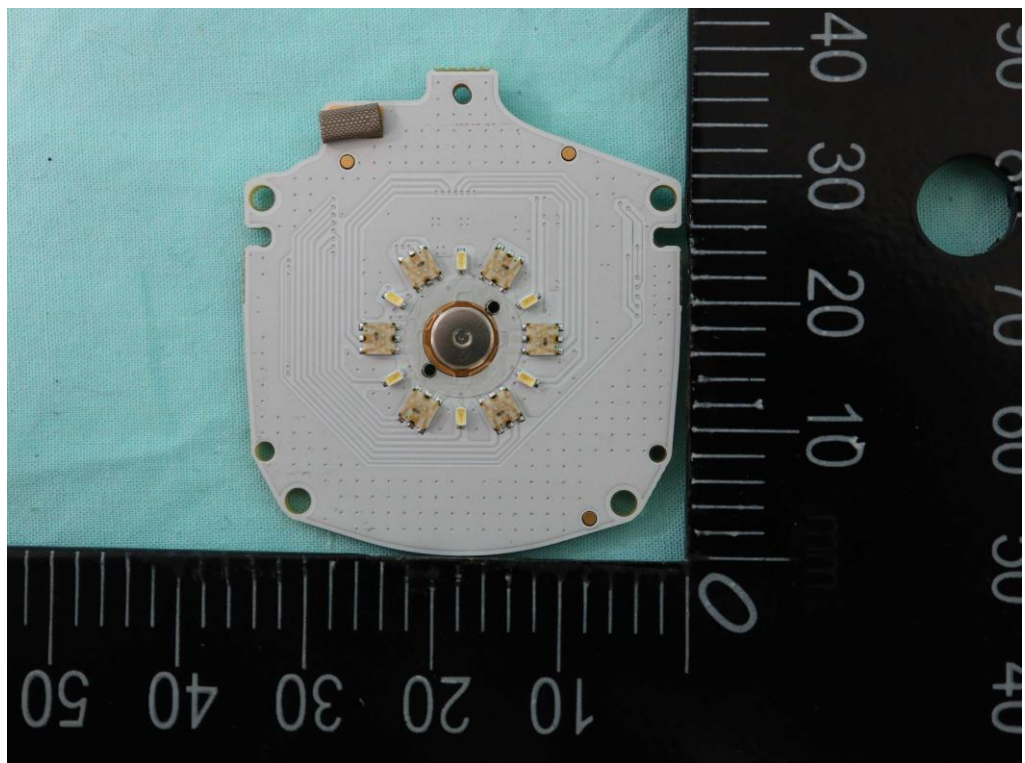
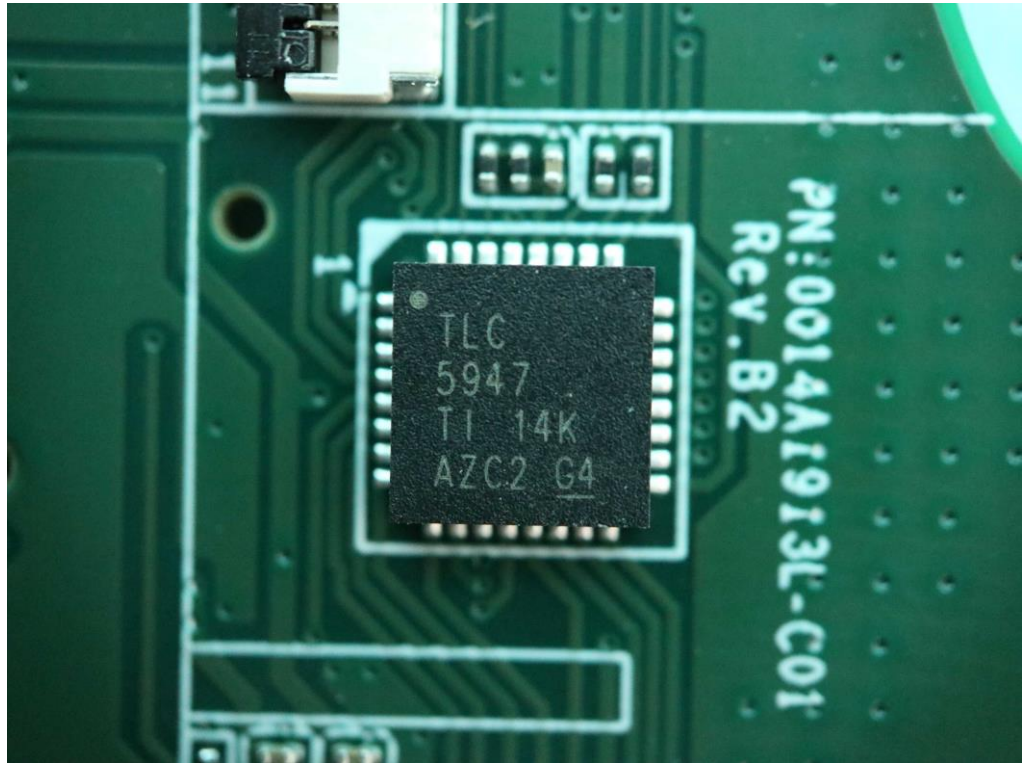


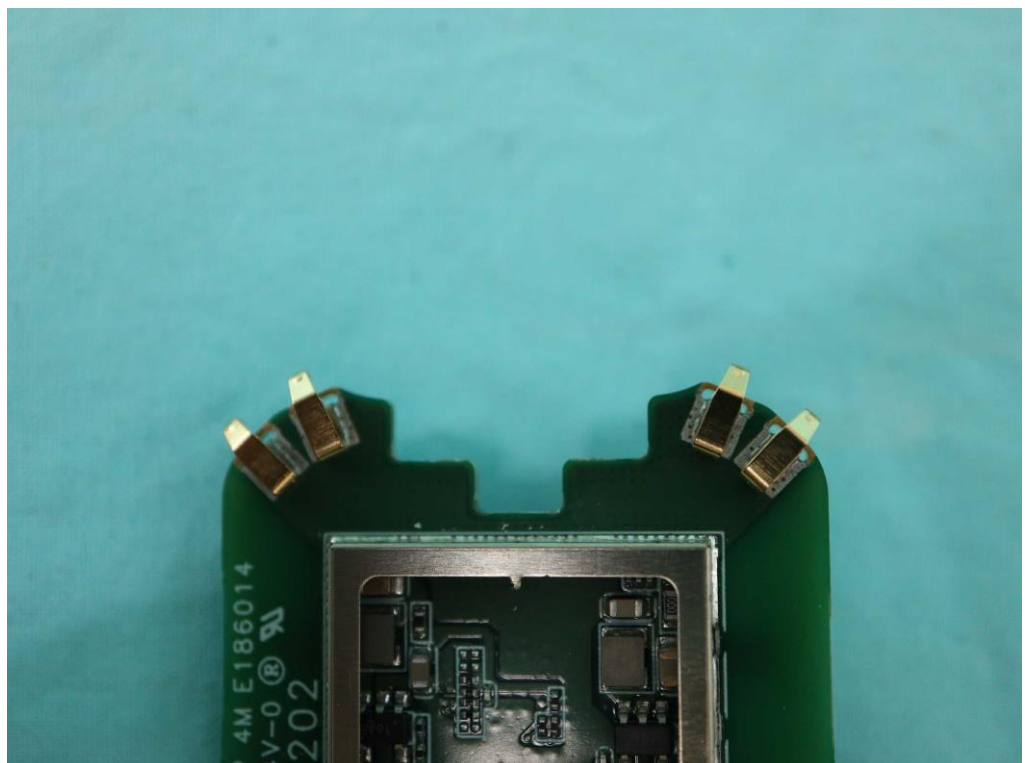
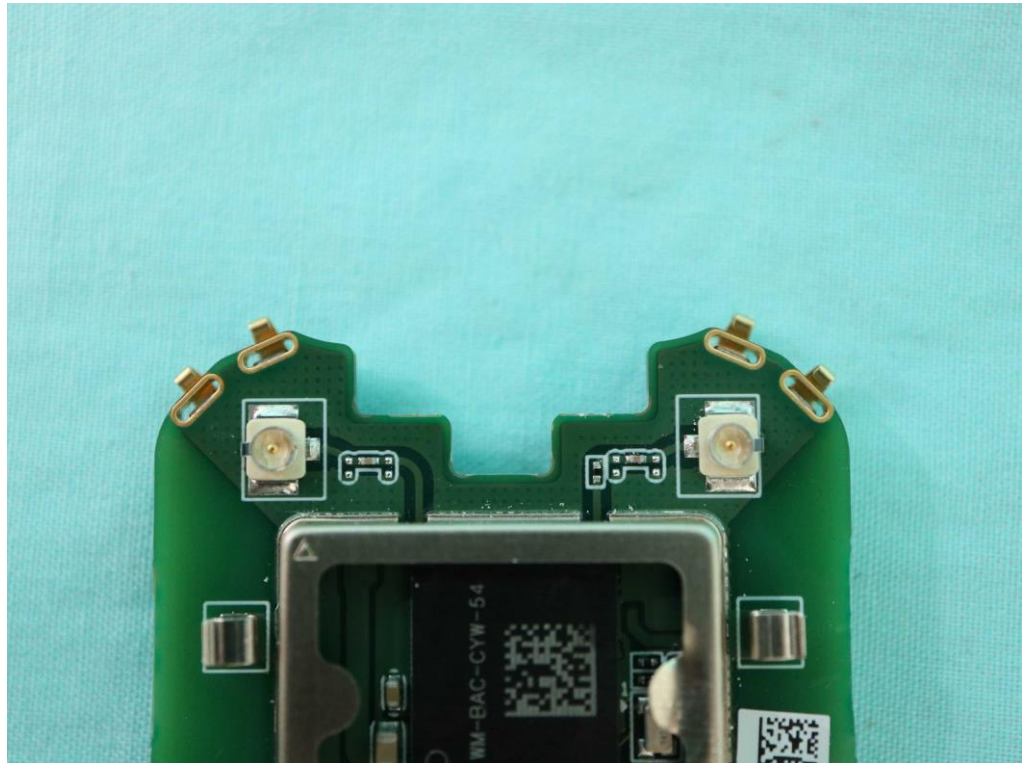




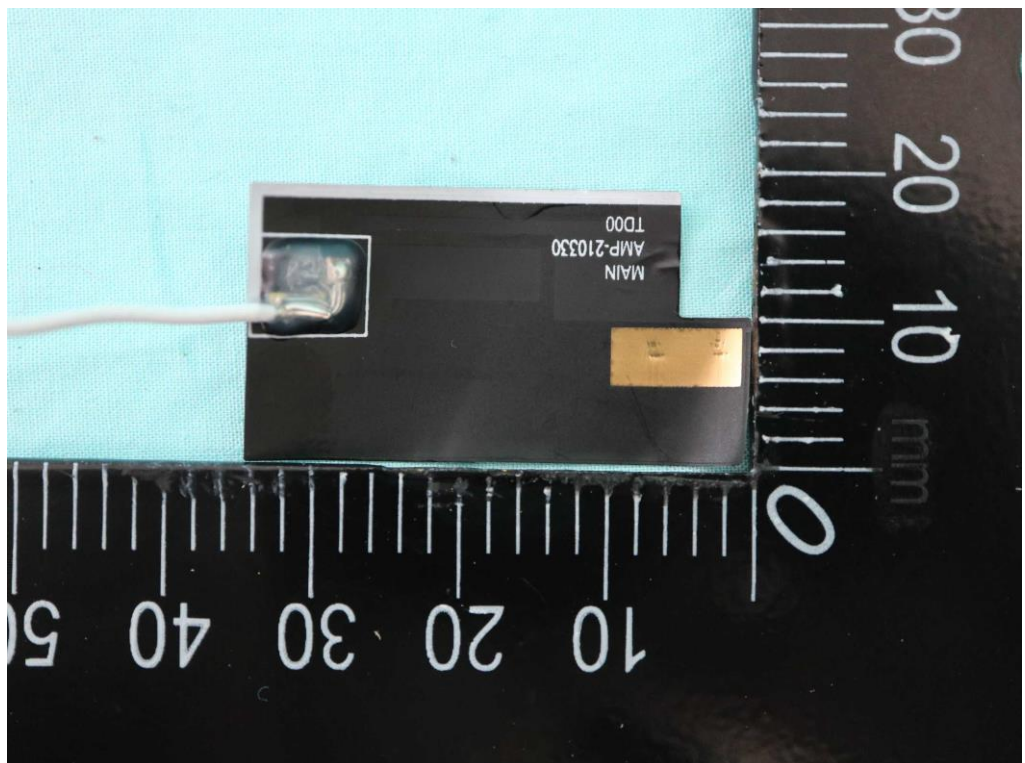
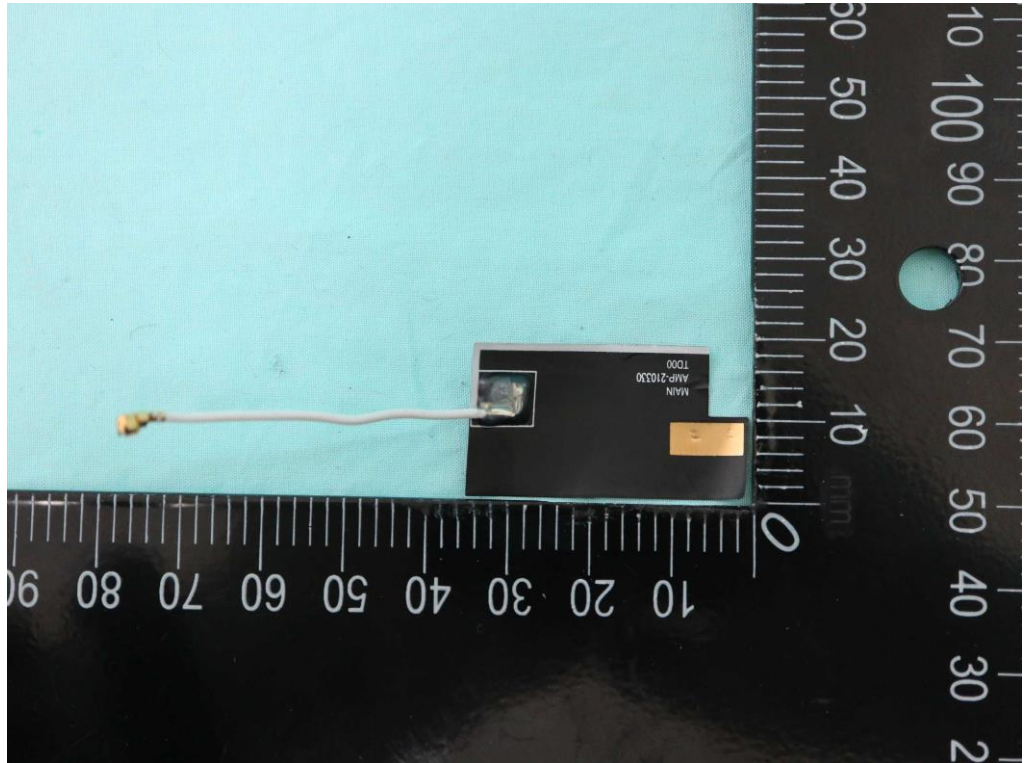


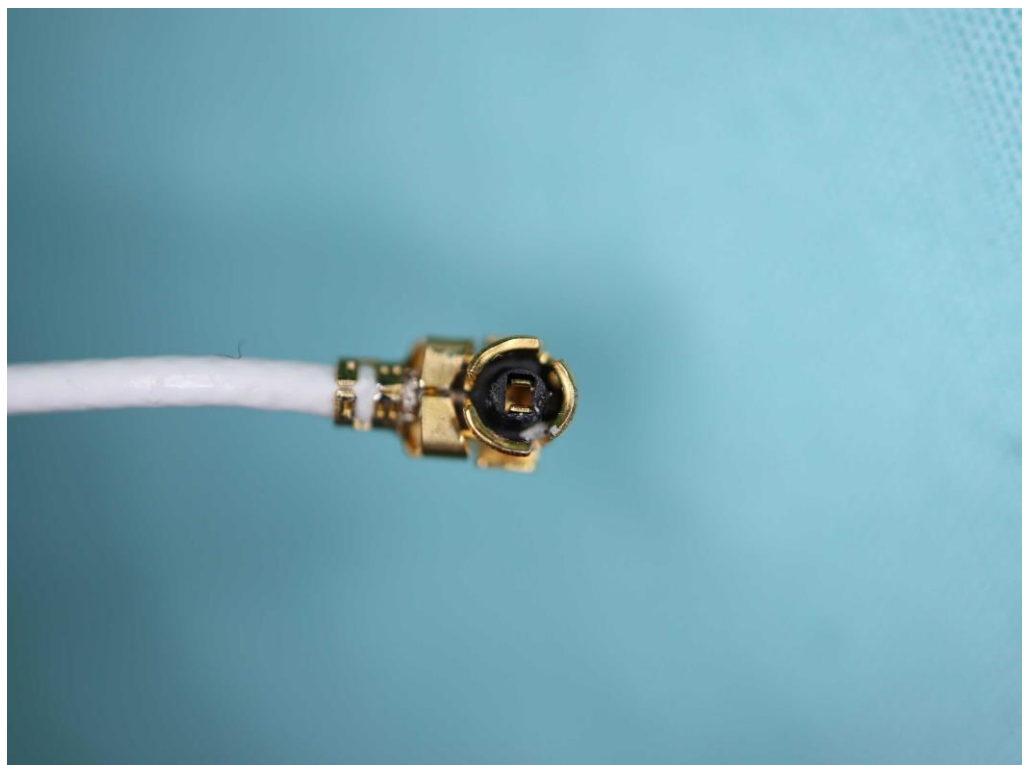
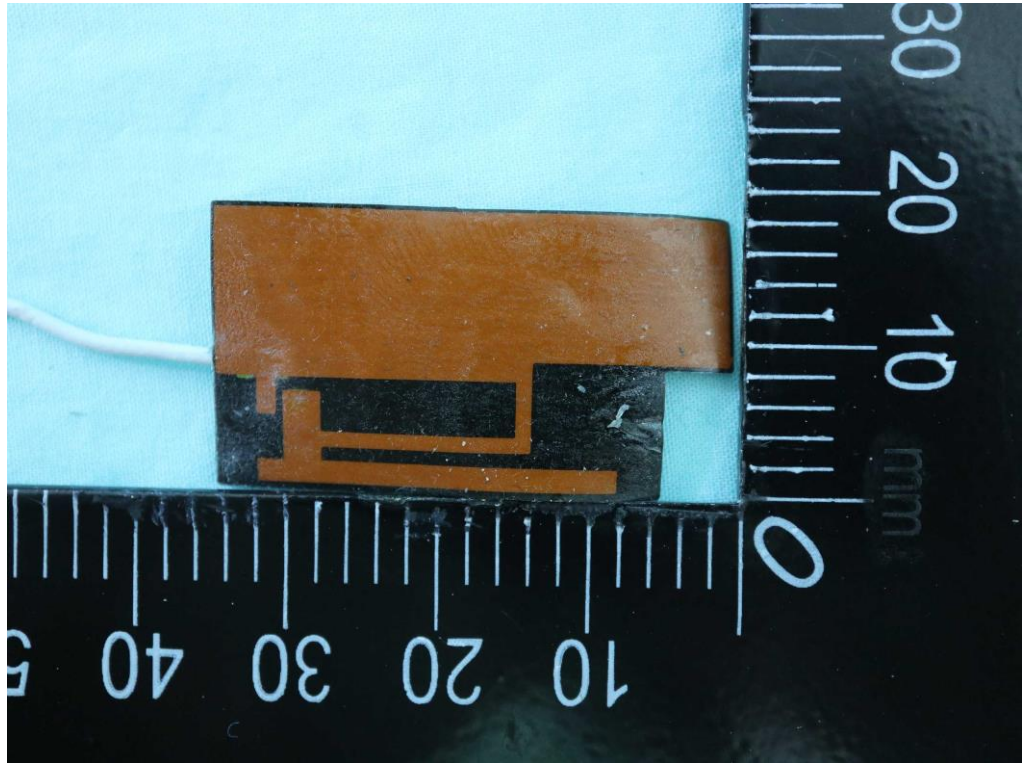




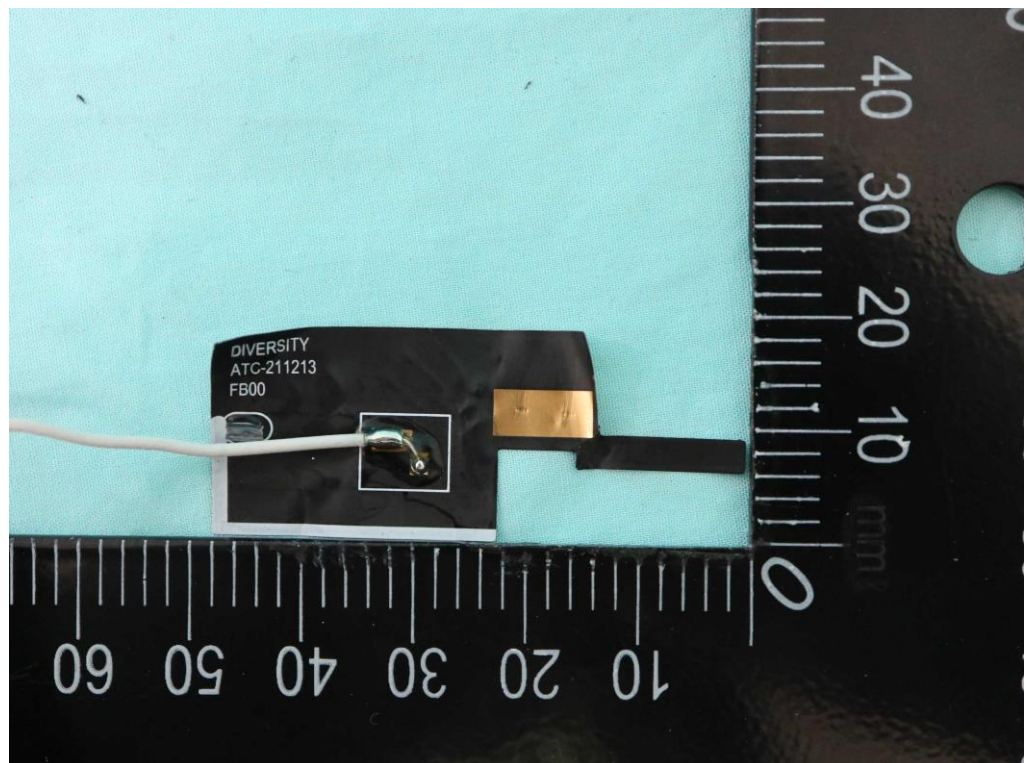
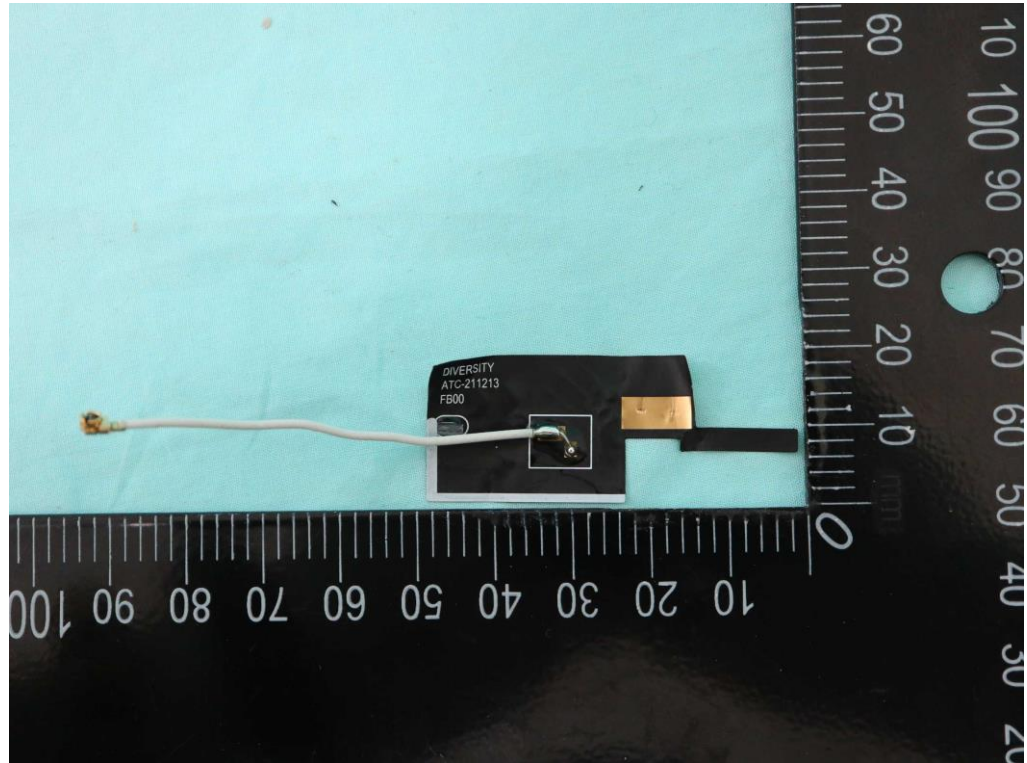


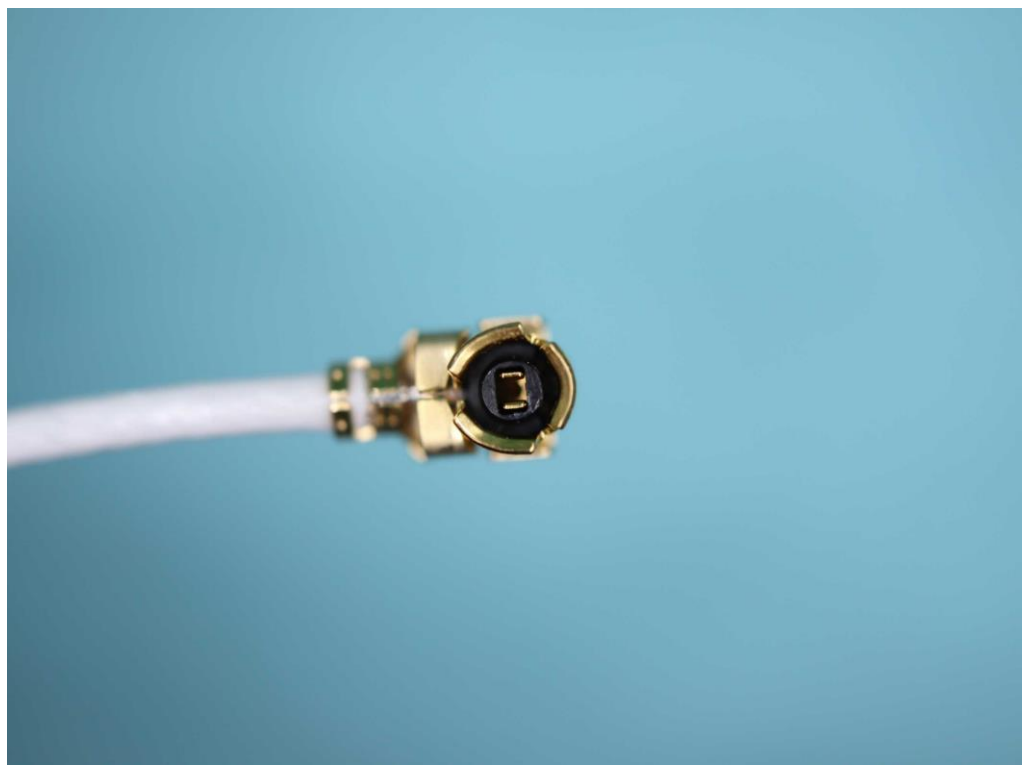
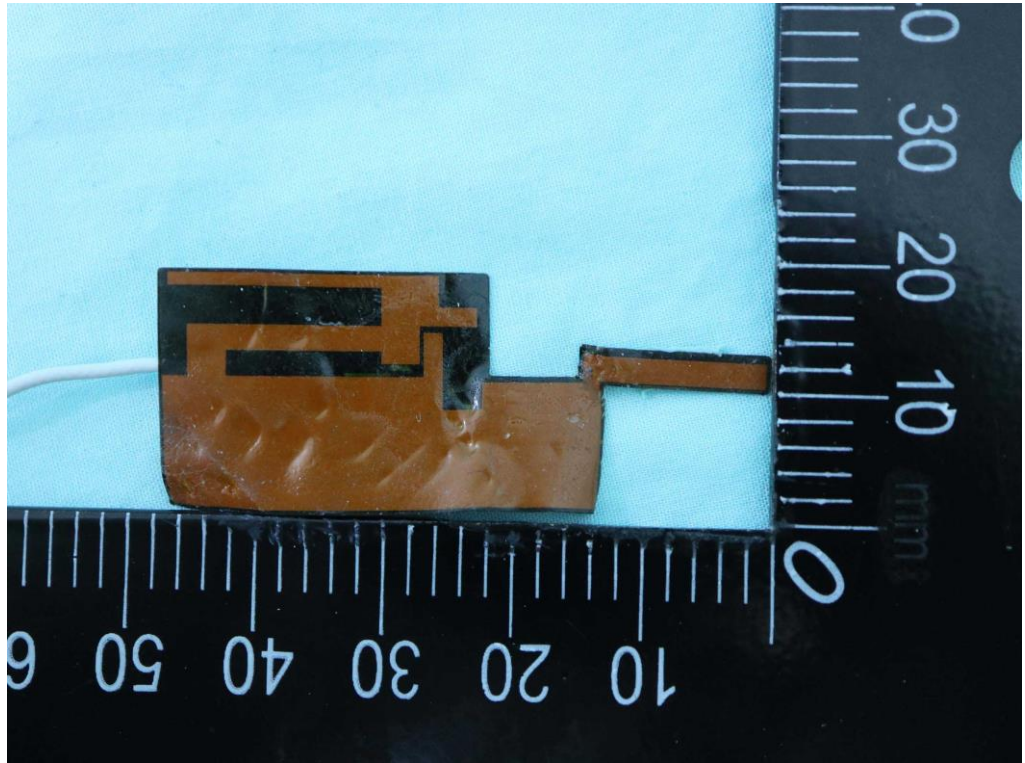












THE END